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# **LED LCD TV SERVICE MANUAL**

**CHASSIS : LD91L**

**MODEL : 42SL9000                  42SL9000-ZA**  
**42SL9500                  42SL9500-ZB**

**CAUTION**

BEFORE SERVICING THE CHASSIS,  
READ THE SAFETY PRECAUTIONS IN THIS MANUAL.



P/NO : MFL58858420 (0909-REV00)

Printed in Korea

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# SAFETY PRECAUTIONS

## IMPORTANT SAFETY NOTICE

Many electrical and mechanical parts in this chassis have special safety-related characteristics. These parts are identified by  $\triangle$  in the Schematic Diagram and Exploded View.

It is essential that these special safety parts should be replaced with the same components as recommended in this manual to prevent Shock, Fire, or other Hazards.

Do not modify the original design without permission of manufacturer.

### General Guidance

An **isolation Transformer** should always be used during the servicing of a receiver whose chassis is not isolated from the AC power line. Use a transformer of adequate power rating as this protects the technician from accidents resulting in personal injury from electrical shocks.

It will also protect the receiver and its components from being damaged by accidental shorts of the circuitry that may be inadvertently introduced during the service operation.

If any fuse (or Fusible Resistor) in this TV receiver is blown, replace it with the specified.

When replacing a high wattage resistor (Oxide Metal Film Resistor, over 1W), keep the resistor 10mm away from PCB.

Keep wires away from high voltage or high temperature parts.

### Before returning the receiver to the customer,

always perform an **AC leakage current check** on the exposed metallic parts of the cabinet, such as antennas, terminals, etc., to be sure the set is safe to operate without damage of electrical shock.

### Leakage Current Cold Check(Antenna Cold Check)

With the instrument AC plug removed from AC source, connect an electrical jumper across the two AC plug prongs. Place the AC switch in the on position, connect one lead of ohm-meter to the AC plug prongs tied together and touch other ohm-meter lead in turn to each exposed metallic parts such as antenna terminals, phone jacks, etc.

If the exposed metallic part has a return path to the chassis, the measured resistance should be between  $1M\Omega$  and  $5.2M\Omega$ .

When the exposed metal has no return path to the chassis the reading must be infinite.

An other abnormality exists that must be corrected before the receiver is returned to the customer.

### Leakage Current Hot Check (See below Figure)

Plug the AC cord directly into the AC outlet.

#### Do not use a line Isolation Transformer during this check.

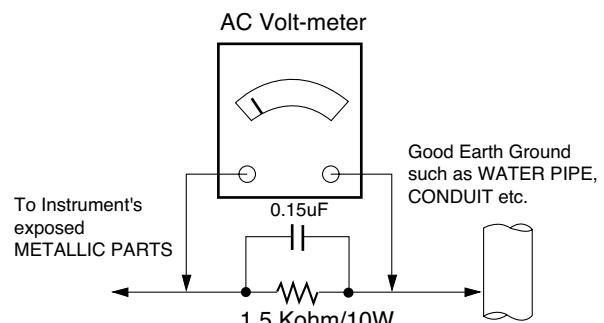
Connect 1.5K/10watt resistor in parallel with a 0.15uF capacitor between a known good earth ground (Water Pipe, Conduit, etc.) and the exposed metallic parts.

Measure the AC voltage across the resistor using AC voltmeter with 1000 ohms/volt or more sensitivity.

Reverse plug the AC cord into the AC outlet and repeat AC voltage measurements for each exposed metallic part. Any voltage measured must not exceed 0.75 volt RMS which corresponds to 0.5mA.

In case any measurement is out of the limits specified, there is possibility of shock hazard and the set must be checked and repaired before it is returned to the customer.

### Leakage Current Hot Check circuit



When 25A is impressed between Earth and 2nd Ground for 1 second, Resistance must be less than  $0.1 \Omega$

\*Base on Adjustment standard

# SERVICING PRECAUTIONS

**CAUTION:** Before servicing receivers covered by this service manual and its supplements and addenda, read and follow the SAFETY PRECAUTIONS on page 3 of this publication.

**NOTE:** If unforeseen circumstances create conflict between the following servicing precautions and any of the safety precautions on page 3 of this publication, always follow the safety precautions. Remember: Safety First.

## General Servicing Precautions

1. Always unplug the receiver AC power cord from the AC power source before;
  - a. Removing or reinstalling any component, circuit board module or any other receiver assembly.
  - b. Disconnecting or reconnecting any receiver electrical plug or other electrical connection.
  - c. Connecting a test substitute in parallel with an electrolytic capacitor in the receiver.
- CAUTION:** A wrong part substitution or incorrect polarity installation of electrolytic capacitors may result in an explosion hazard.
2. Test high voltage only by measuring it with an appropriate high voltage meter or other voltage measuring device (DVM, FETVOM, etc) equipped with a suitable high voltage probe.  
Do not test high voltage by "drawing an arc".
3. Do not spray chemicals on or near this receiver or any of its assemblies.
4. Unless specified otherwise in this service manual, clean electrical contacts only by applying the following mixture to the contacts with a pipe cleaner, cotton-tipped stick or comparable non-abrasive applicator; 10% (by volume) Acetone and 90% (by volume) isopropyl alcohol (90%-99% strength)  
**CAUTION:** This is a flammable mixture.  
Unless specified otherwise in this service manual, lubrication of contacts is not required.
5. Do not defeat any plug/socket B+ voltage interlocks with which receivers covered by this service manual might be equipped.
6. Do not apply AC power to this instrument and/or any of its electrical assemblies unless all solid-state device heat sinks are correctly installed.
7. Always connect the test receiver ground lead to the receiver chassis ground before connecting the test receiver positive lead.  
Always remove the test receiver ground lead last.
8. Use with this receiver only the test fixtures specified in this service manual.  
**CAUTION:** Do not connect the test fixture ground strap to any heat sink in this receiver.

## Electrostatically Sensitive (ES) Devices

Some semiconductor (solid-state) devices can be damaged easily by static electricity. Such components commonly are called Electrostatically Sensitive (ES) Devices. Examples of typical ES devices are integrated circuits and some field-effect transistors and semiconductor "chip" components. The following techniques should be used to help reduce the incidence of component damage caused by static by static electricity.

1. Immediately before handling any semiconductor component or semiconductor-equipped assembly, drain off any electrostatic charge on your body by touching a known earth ground. Alternatively, obtain and wear a commercially available discharging wrist strap device, which should be removed to prevent potential shock reasons prior to applying power to the

unit under test.

2. After removing an electrical assembly equipped with ES devices, place the assembly on a conductive surface such as aluminum foil, to prevent electrostatic charge buildup or exposure of the assembly.
3. Use only a grounded-tip soldering iron to solder or unsolder ES devices.
4. Use only an anti-static type solder removal device. Some solder removal devices not classified as "anti-static" can generate electrical charges sufficient to damage ES devices.
5. Do not use freon-propelled chemicals. These can generate electrical charges sufficient to damage ES devices.
6. Do not remove a replacement ES device from its protective package until immediately before you are ready to install it. (Most replacement ES devices are packaged with leads electrically shorted together by conductive foam, aluminum foil or comparable conductive material).
7. Immediately before removing the protective material from the leads of a replacement ES device, touch the protective material to the chassis or circuit assembly into which the device will be installed.  
**CAUTION:** Be sure no power is applied to the chassis or circuit, and observe all other safety precautions.
8. Minimize bodily motions when handling unpackaged replacement ES devices. (Otherwise harmless motion such as the brushing together of your clothes fabric or the lifting of your foot from a carpeted floor can generate static electricity sufficient to damage an ES device.)

## General Soldering Guidelines

1. Use a grounded-tip, low-wattage soldering iron and appropriate tip size and shape that will maintain tip temperature within the range of 500°F to 600°F.
2. Use an appropriate gauge of RMA resin-core solder composed of 60 parts tin/40 parts lead.
3. Keep the soldering iron tip clean and well tinned.
4. Thoroughly clean the surfaces to be soldered. Use a small wire-bristle (0.5 inch, or 1.25cm) brush with a metal handle.  
Do not use freon-propelled spray-on cleaners.
5. Use the following unsoldering technique
  - a. Allow the soldering iron tip to reach normal temperature. (500°F to 600°F)
  - b. Heat the component lead until the solder melts.
  - c. Quickly draw the melted solder with an anti-static, suction-type solder removal device or with solder braid.  
**CAUTION:** Work quickly to avoid overheating the circuit board printed foil.
6. Use the following soldering technique
  - a. Allow the soldering iron tip to reach a normal temperature (500°F to 600°F)
  - b. First, hold the soldering iron tip and solder the strand against the component lead until the solder melts.
  - c. Quickly move the soldering iron tip to the junction of the component lead and the printed circuit foil, and hold it there only until the solder flows onto and around both the component lead and the foil.  
**CAUTION:** Work quickly to avoid overheating the circuit board printed foil.
  - d. Closely inspect the solder area and remove any excess or splashed solder with a small wire-bristle brush.

### **IC Remove/Replacement**

Some chassis circuit boards have slotted holes (oblong) through which the IC leads are inserted and then bent flat against the circuit foil. When holes are the slotted type, the following technique should be used to remove and replace the IC. When working with boards using the familiar round hole, use the standard technique as outlined in paragraphs 5 and 6 above.

#### **Removal**

1. Desolder and straighten each IC lead in one operation by gently prying up on the lead with the soldering iron tip as the solder melts.
2. Draw away the melted solder with an anti-static suction-type solder removal device (or with solder braid) before removing the IC.

#### **Replacement**

1. Carefully insert the replacement IC in the circuit board.
2. Carefully bend each IC lead against the circuit foil pad and solder it.
3. Clean the soldered areas with a small wire-bristle brush. (It is not necessary to reapply acrylic coating to the areas).

### **"Small-Signal" Discrete Transistor**

#### **Removal/Replacement**

1. Remove the defective transistor by clipping its leads as close as possible to the component body.
2. Bend into a "U" shape the end of each of three leads remaining on the circuit board.
3. Bend into a "U" shape the replacement transistor leads.
4. Connect the replacement transistor leads to the corresponding leads extending from the circuit board and crimp the "U" with long nose pliers to insure metal to metal contact then solder each connection.

### **Power Output, Transistor Device**

#### **Removal/Replacement**

1. Heat and remove all solder from around the transistor leads.
2. Remove the heat sink mounting screw (if so equipped).
3. Carefully remove the transistor from the heat sink of the circuit board.
4. Insert new transistor in the circuit board.
5. Solder each transistor lead, and clip off excess lead.
6. Replace heat sink.

### **Diode Removal/Replacement**

1. Remove defective diode by clipping its leads as close as possible to diode body.
2. Bend the two remaining leads perpendicular y to the circuit board.
3. Observing diode polarity, wrap each lead of the new diode around the corresponding lead on the circuit board.
4. Securely crimp each connection and solder it.
5. Inspect (on the circuit board copper side) the solder joints of the two "original" leads. If they are not shiny, reheat them and if necessary, apply additional solder.

### **Fuse and Conventional Resistor**

#### **Removal/Replacement**

1. Clip each fuse or resistor lead at top of the circuit board hollow stake.
2. Securely crimp the leads of replacement component around notch at stake top.
3. Solder the connections.

**CAUTION:** Maintain original spacing between the replaced component and adjacent components and the circuit board to prevent excessive component temperatures.

### **Circuit Board Foil Repair**

Excessive heat applied to the copper foil of any printed circuit board will weaken the adhesive that bonds the foil to the circuit board causing the foil to separate from or "lift-off" the board. The following guidelines and procedures should be followed whenever this condition is encountered.

#### **At IC Connections**

To repair a defective copper pattern at IC connections use the following procedure to install a jumper wire on the copper pattern side of the circuit board. (Use this technique only on IC connections).

1. Carefully remove the damaged copper pattern with a sharp knife. (Remove only as much copper as absolutely necessary).
2. carefully scratch away the solder resist and acrylic coating (if used) from the end of the remaining copper pattern.
3. Bend a small "U" in one end of a small gauge jumper wire and carefully crimp it around the IC pin. Solder the IC connection.
4. Route the jumper wire along the path of the out-away copper pattern and let it overlap the previously scraped end of the good copper pattern. Solder the overlapped area and clip off any excess jumper wire.

#### **At Other Connections**

Use the following technique to repair the defective copper pattern at connections other than IC Pins. This technique involves the installation of a jumper wire on the component side of the circuit board.

1. Remove the defective copper pattern with a sharp knife. Remove at least 1/4 inch of copper, to ensure that a hazardous condition will not exist if the jumper wire opens.
2. Trace along the copper pattern from both sides of the pattern break and locate the nearest component that is directly connected to the affected copper pattern.
3. Connect insulated 20-gauge jumper wire from the lead of the nearest component on one side of the pattern break to the lead of the nearest component on the other side. Carefully crimp and solder the connections.

**CAUTION:** Be sure the insulated jumper wire is dressed so the it does not touch components or sharp edges.

# SPECIFICATION

NOTE : Specifications and others are subject to change without notice for improvement.

## 1. Application range

This specification is applied to the LED LCD TV used LD91L chassis.

## 2. Requirement for Test

Each part is tested as below without special appointment.

- 1) Temperature :  $25\pm 5^{\circ}\text{C}$  ( $77\pm 9^{\circ}\text{F}$ ), CST :  $40\pm 5^{\circ}\text{C}$
- 2) Relative Humidity :  $65\pm 10\%$
- 3) Power Voltage : Standard input voltage(100-240V@  
50/60Hz)  
\* Standard Voltage of each products is marked by models.
- 4) Specification and performance of each parts are followed  
each drawing and specification by part number in  
accordance with BOM.
- 5) The receiver must be operated for about 5 minutes prior to  
the adjustment.

## 3. Test method

- 1) Performance: LGE TV test method followed
- 2) Demanded other specification
  - Safety: CE, IEC specification
  - EMC:CE, IEC

## 4. Electrical specification

- Module General Specification

No	Item	Specification	Remark
1	Screen Device	42" wide color display module	
2	Aspect Ratio	16:9	
3	LCD Module	42" TFT LCD FHD 200Hz	
4	Operating Environment	Temp. : 0 ~ 50 deg	
		Humidity : 10 ~ 90%	
4	Storage Environment	Temp. : -20 ~ 60 deg	
		Humidity : 10 ~ 90 %	
5	Input Voltage	AC100-240V~, 50/60Hz	
6	Power Consumption	Power on (White)	LCD (Module) + Backlight(LED)
		Typ : 154, Max : 168	
7	Module Size	973.2 (H) x 566.2 (V) x 11.9(B)/25.5mm (D)	With inverter
8	Pixel Pitch	0.4845 (H) x 0.4845 (D)	
9	Back Light	LED	
10	Display Colors	1.06Billion colors (10 bit)	
11	Coating	3H(Hard coating)	

## 5. Chroma & Brightness

- Module optical specification
- (1) LGD Module

No.	Item	Specification		Min.	Typ.	Max.	Remark
1.	Viewing Angle<CR>10>	Right/Left/Up/Down		89			CR>10
2.	Luminance	Luminance (cd/m <sup>2</sup> )			450		
		Variation			-	1.3	MAX /MIN
3.	Contrast Ratio	CR		900	1300		
4.	CIE Color Coordinates	White	Wx		0.279	Typ ±0.03	
			Wy		0.292		
		RED	Xr		0.640		
			Yr		0.331		
		Green	Xg		0.282		
			Yg		0.634		
		Blue	Xb		0.151		
			Yb		0.057		

- 1) Standard Test Condition (The unit has been 'ON')
- 2) Stable for approximately 30 minutes in a dark environment at 25±2°C.
- 3) The values specified are at approximate distance 50Cm from the LCD surface
- 4) Ta=25±2°C, VLCD=12.0V, fV=60Hz, Dclk=74.25MHz VBR\_A=1.65V, ExtVBR\_B=85%

## 6. Component Video Input (Y, Cb/Pb, Cr/Pr)

No	Specification				Remark
	Resolution	H-freq(kHz)	V-freq(Hz)		
1.	720x480	15.73	60.00	SDTV,DVD 480i	
2.	720x480	15.63	59.94	SDTV,DVD 480i	
3.	720x480	31.47	59.94	480p	
4.	720x480	31.50	60.00	480p	
5.	720x576	15.625	50.00	SDTV,DVD 625 Line	
6.	720x576	31.25	50.00	HDTV 576p	
7.	1280x720	45.00	50.00	HDTV 720p	
8.	1280x720	44.96	59.94	HDTV 720p	
9.	1280x720	45.00	60.00	HDTV 720p	
10.	1920x1080	31.25	50.00	HDTV 1080i	
11.	1920x1080	33.75	60.00	HDTV 1080i	
12.	1920x1080	33.72	59.94	HDTV 1080i	
13.	1920x1080	56.250	50	HDTV 1080p	
14.	1920x1080	67.43/67.5	59.94/60	HDTV 1080p	

## 7. RGB Input(PC)

No	Specification				Proposed	Remark
	Resolution	H-freq(kHz)	V-freq(Hz)	Pixel Clock(MHz)		
1.	720*400	31.468	70.08			For only DOS mode
2.	640*480	31.469	59.94			Input 848*480 60Hz, 852*480 60Hz -> 640*480 60Hz Display
3.	800*600	37.879	60.31			
4.	1024*768	48.363	60.00			
5.	1280*768	47.78	59.87			
6.	1360*768	47.72	59.8			
7.	1280*1024	63.595	60.00			
8.	1920*1080	66.587	59.93			
9.	1366*768	47.13	59.65			

## 8. HDMI Input

### (1) DTV Mode

No	Resolution	H-freq(kHz)	V-freq.(Hz)	Pixel clock(MHz)	Proposed	Remark
1.	720*480	31.469 /31.5	59.94 /60	27.00/27.03	SDTV 480P	
2.	720*576	31.25	50	54	SDTV 576P	
3.	1280*720	37.500	50	74.25	HDTV 720P	
4.	1280*720	44.96 /45	59.94 /60	74.17/74.25	HDTV 720P	
5.	1920*1080	33.72 /33.75	59.94 /60	74.17/74.25	HDTV 1080I	
6.	1920*1080	28.125	50.00	74.25	HDTV 1080I	
7.	1920*1080	26.97 /27	23.97 /24	74.17/74.25	HDTV 1080P	
8.	1920*1080	33.716 /33.75	29.976 /30.00	74.25	HDTV 1080P	
9.	1920*1080	56.250	50	148.5	HDTV 1080P	
10.	1920*1080	67.43 /67.5	59.94 /60	148.35/148.50	HDTV 1080P	

### (2) PC Mode

No	Specification				Proposed	Remark
	Resolution	H-freq(kHz)	V-freq(Hz)	Pixel Clock(MHz)		
1.	720*400	31.468	70.08			For only DOS mode
2.	640*480	31.469	59.94			Input 848*480 60Hz, 852*480 60Hz -> 640*480 60Hz Display
3.	800*600	37.879	60.31			
4.	1024*768	48.363	60.00			
5.	1280*768	47.78	59.87			
6.	1360*768	47.72	59.8			
7.	1280*1024	63.595	60.00			
8.	1920*1080	66.587	59.93			
9.	1366*768	47.13	59.65			

# ADJUSTMENT INSTRUCTION

## 1. Application Range

This specification sheet is applied to all of the LED LCD TV with LD91L chassis.

## 2. Designation

- 1) The adjustment is according to the order which is designated and which must be followed, according to the plan which can be changed only on agreeing.
- 2) Power Adjustment: Free Voltage
- 3) Magnetic Field Condition: Nil.
- 4) Input signal Unit: Product Specification Standard
- 5) Reserve after operation: Above 5 Minutes (Heat Run)
  - Temperature : at  $25\pm 5^{\circ}\text{C}$
  - Relative humidity :  $65\pm 10\%$
  - Input voltage : 220V, 60Hz
- 6) Adjustment equipments: Color Analyzer (CA-210 or CA-110), Pattern Generator(MSPG-925 Series or Equivalent), DDC Adjustment Jig equipment, Service Remote Control.
- 7) Push The "IN STOP KEY" - For memory initialization.

Case1 : Software version up

1. After downloading S/W by USB, TV set will reboot automatically.
2. Push "In-stop" key.
3. Push "Power on" key.
4. Function inspection
5. After function inspection, Push "I n-stop" key.

Case2 : Function check at the assembly line

1. When TV set is entering on the assembly line, Push "In-stop" key at first.
2. Push "Power on" key for turning it on.
  - > If you push "Power on" key, TV set will recover channel information by itself.
3. After function inspection, Push "In-stop" key.

## 3. Main PCB check process

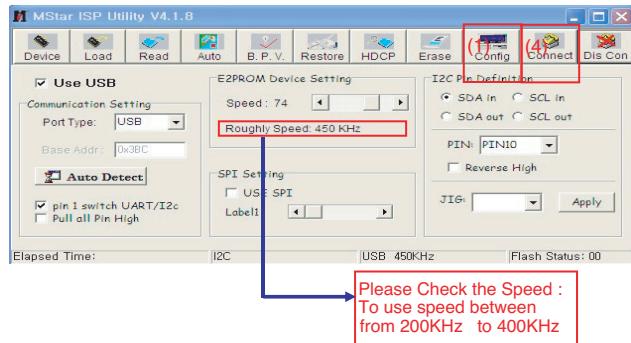
\* APC - After Manual-Insult, executing APC

### \* Boot file Download

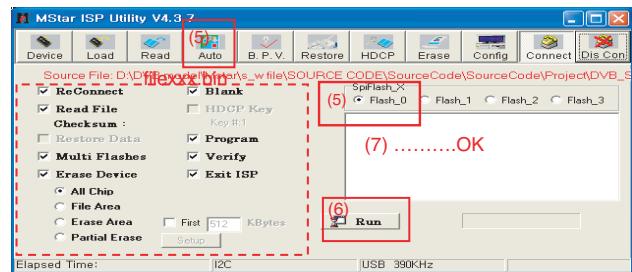
- 1) Execute ISP program "Mstar ISP Utility" and then click "Config" tab.
- 2) Set as below, and then click "Auto Detect" and check "OK" message
  - If "Error" is displayed, Check connection between computer, jig, and set.
- 3) Click "Read" tab, and then load download file (XXXX.bin) by clicking "Read"



- 4) Click "Connect" tab. If "Can't" is displayed, check connection between computer, jig, and set.

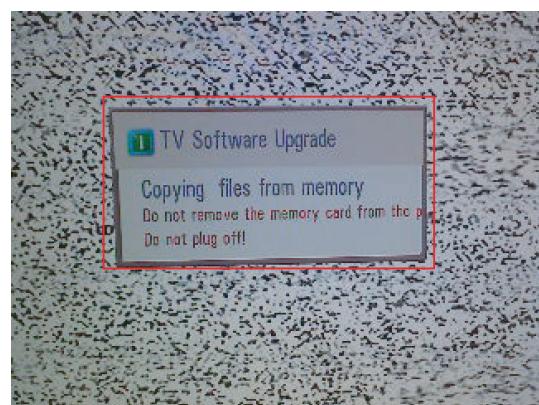


- 5) Click "Auto" tab and set as below
- 6) Click "Run".
- 7) After downloading, check "OK" message.



### \* USB DOWNLOAD

- 1) Put the USB Stick to the USB socket
- 2) Automatically detecting update file in USB Stick
  - If your downloaded program version in USB Stick is Low, it didn't work. But your downloaded version is High, USB data is automatically detecting
- 3) Show the message "Copying files from memory"



4) Updating is staring.



5) Updating Completed, The TV will restart automatically.

- 6) If your TV is turned on, check your updated version and Tool option. (explain the Tool option, next stage)
- \* If downloading version is more high than your TV have, TV can lost all channel data. In this case, you have to channel recover. if all channel data is cleared, you didn't have a DTV/ATV test on production line.

\* After downloading, have to adjust Tool Option again.

- 1) Push "IN-START" key in service remote controller
- 2) Select "Tool Option 1" and Push "OK" button.
- 3) Punch in the number. (Each model has their number)

Model	Tool option1	Tool option2	Tool option3	Tool option4
SL9xxx	26305	3106	57254	3360

4) Completed selecting Tool option.

### 3.1. ADC Process

- (1) External ADC(Only adjust in the component mode 480i)
- Input the signal in the Component 1 - Component 480i  
(Adjusted only this mode)
- MODEL: 209 in Pattern Generator(480i Mode)  
PATTERN : 65 in Pattern Generator(MSPG-925 SERIES)



Adjustment pattern

- After enter Service Mode by pushing "ADJ" key,
- Enter the 5 item and then Push the "Start" key.

- (2) Internal ADC(Only adjust in the RGB)

- After enter Service Mode by pushing "ADJ" key
- Enter ADC Calibration mode by pushing "▶" key at "5. ADC Calibration"

<Caution> Using 'power on' button of the Adjustment R/C , power on TV.

\* ADC Calibration Protocol (RS232)

Item	CMD1	CMD2	Data0	
Adjust 'Mode In'	A	A	0	When transfer the 'Mode In', Carry the command.
ADC Adjust	A	D	1	Automatically adjustment (The use of a internal pattern)

Adjust Sequence

- aa 00 00 [Enter Adjust Mode]
- xb 00 40 [Component1 Input (480i)]
- ad 00 10 [Adjust 480i Comp1]
- xb 00 60 [RGB Input (1024\*768)]
- ad 00 10 [Adjust 1024\*768 RGB]
- aa 00 90 End Adjust mode

### 3.2. Function Check

- (1) Check display and sound

- Check Input and Signal items. (cf. work instructions)

- 1) TV
- 2) AV (SCART1/SCART2/ CVBS)
- 3) COMPONENT (480i)
- 4) RGB (PC : 1024 x 768 @ 60hz)
- 5) HDMI
- 6) PC Audio In

\* Display and Sound check is executed by Remote control.

<Caution>

Not to push the INSTOP key after completion if the function inspection.

## 4. Total Assembly line process

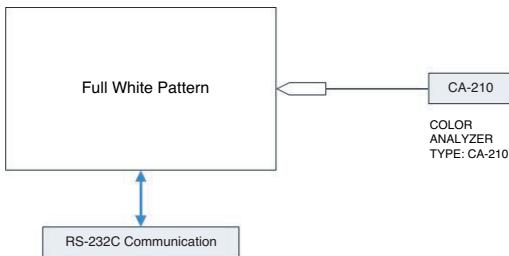
### 4.1. Adjustment Preparation

- W/B Equipment condition  
CA210 : CH 14(LED), Test signal : Inner pattern (85IRE)
- Above 5 minutes H/run in the inner pattern. ("power on" key of adjust remote control)

Cool	13,000k	°K	X=0.269(±0.002) Y=0.273(±0.002)	<Test Signal> Inner pattern (216gray,85IRE)
Medium	9,300k	°K	X=0.285(±0.002) Y=0.293(±0.002)	
Warm	6,500k	°K	X=0.313(±0.002) Y=0.329(±0.002)	

\* Connecting picture of the measuring instrument  
(On Automatic control)

Inside PATTERN is used when W/B is controlled. Connect to auto controller or push Adjustment R/C POWER ON -> Enter the mode of White-Balance, the pattern will come out



\* Auto-control interface and directions

- Adjust in the place where the influx of light like floodlight around is blocked. (illumination is less than 10 lux).
- Adhere closely the Color Analyzer (CA210) to the module less than 10cm distance, keep it with the surface of the Module and Color Analyzer's Probe vertically.(80~100°).
- Aging time
  - After aging start, keep the power on (no suspension of power supply) and heat-run over 15minutes.
  - Using 'no signal' or 'full white pattern' or the others, check the back light on.

• Auto adjustment Map(RS-232C)

RS-232C COMMAND

[CMD Format]

START 6E A 50 A LEN A 03 A CMD A 00 A VAL A CS A STOP

- LEN : Number of Data Byte to be send
  - CMD : Command
  - VAL : FOS Data
  - CS : Checksum of sent Data
  - A : Acknowledge
- Ex) [Send : JA\_00\_DD] / [Ack : A\_00\_okDDX]

[CMD ID DATA]

Wb 00 00	White Balance Start
Wb 00 ff	White Balance End

	RS-232C COMMAND [CMD ID DATA]			MIN	CENTER (DEFAULT)			MAX
	Cool	Mid	Warm		Cool	Mid	Warm	
R Gain	jg	Ja	jd	00	172	192	192	255
G Gain	jh	Jb	je	00	172	192	192	255
B Gain	ji	Jc	jf	00	192	192	172	255
R Cut					64	64	64	128
G Cut					64	64	64	128
B Cut					64	64	64	128

In the SET applied LED module, as to physical characteristics of LED Module, the sets takes a 120 minutes by aging time to stabilize a color coordinates. So White Balance Control equipments get the SET Aging Time from SET and then going to control the W/B by revise color coordinates in the each time

Cautions) The Time Table of color coordinates by SET Aging Time

	H/R Time (Min)	Cool		Medium		Warm	
		X	Y	X	Y	X	Y
		269	273	285	293	313	329
1	~5	281	297	290	307	318	343
2	6~20	280	288	289	301	317	338
3	21~30	278	285	287	297	316	334
4	31~	276	283	285	293	313	329

\*\* Caution \*\*

Color Temperature : COOL, Medium, Warm.

One of R Gain/ G Gain/ B Gain should be kept on 0xC0, and adjust other two lower than C0.  
(when R/G/B Gain are all C0, it is the FULL Dynamic Range of Module)

\* Manual W/B process using adjusts Remote control.

Dynamic contrast : off

Dynamic color : off

OPC : off

Energy saving mode : off

- After enter Service Mode by pushing "ADJ" key,
- Enter White Balance by pushing "▶" key at "3. White Balance".



- In the SET applied LED module, as to physical characteristics of LED Module, the sets takes a 120 minutes by aging time to stabilize a color coordinates. So White Balance Control equipments get the SET Aging Time from SET and then going to control the W/B by revise color coordinates in the each time

Cautions) The Time Table of color coordinates by SET Aging Tim

	H/R Time (Min)	Cool		Medium		Warm	
		X	Y	X	Y	X	Y
		269	273	285	293	313	329
1	~5	281	297	290	307	318	343
2	6~20	280	288	289	301	317	338
3	21~30	278	285	287	297	316	334
4	31~	276	283	285	293	313	329

- \* After done all adjustments, Press “In-start” button and compare Tool option and Area option value with its BOM, if it is correctly same then unplug the AC cable. If it is not same, then correct it same with BOM and unplug AC cable. For correct it to the model’s module from factory JIG model.
  - \* Push The “IN STOP KEY” after completing the function inspection.

#### **4.2. DDC EDID Write (RGB 128Byte)**

- Write EDID Data to EEPROM(24C02) by using DDC2B protocol.
  - Check whether written EDID data is correct or not.
  - \* For SVC main Ass'y, EDID have to be downloaded to Insert Process in advance.

#### **4.3. DDC EDID Write (HDMI 256Byte)**

- Check whether written EDID data is correct or not.
  - \* For SVC main Ass'y, EDID have to be downloaded to Insert Process in advance.

#### 4.4. EDID DATA

- 1) All Data : HEXA Value
  - 2) Changeable Data :
    - \*: Serial No : Controlled / Data:01
    - \*\*: Month : Controlled / Data:00
    - \*\*\*:Year : Controlled
    - \*\*\*\*:Check sum

### - Auto Download

- After enter Service Mode by pushing “ADJ” key.
  - Enter EDID D/L mode.
  - Enter “START” by pushing “OK” key.

\* Edid data and Model option download (RS232)

Item	CMD1	CMD2	Data0		
Download 'Mode In'	A	A	0	0	When transfer the 'Mode In', Carry the command.
Download	A	E	00	10	Automatically Download (The use of a internal Data)

<Caution>

- Never connect HDMI & D-sub cable when the user downloading.
  - Use the proper cables below for EDID Writing



## - Manual Download

- \* Caution
    - Use the proper signal cable for EDID Download
      - Analog EDID : Pin3 exists
      - Digital EDID : Pin3 exists
    - Never connect HDMI & D-sub Cable at the same time.
    - Use the proper cables below for EDID Writing.
    - Download HDMI1, HDMI2, separately because HDMI1 is different from HDMI2.

For Analog EDID	For HDMI EDID
D-sub to D-sub	DVI-D to HDMI or HDMI to HDMI
	

No.	Item	Condition	Hex Data
1	ManufacturerID	GSM	1E6D
2	Version	Digital : 1	01
3	Revision	Digital : 3	03

1) Analog Data 128Byte (2Bi)

## 2) DIGITAL DATA(HDMI-1/2/3/4) 256Byte

\* Detail EDID Options are below  
Product ID

Model Name	HEX	EDID Table	DDC Function
**SL9****	0001	0100	Analog
	0000	0100	Digital

Serial No: Controlled on production line.

Month, Year: Controlled on production line:

ex) Monthly : '02' -> '02'  
Year : '2009' -> '13'

Model Name(HEX):

MODEL	MODEL NAME(HEX)
42SL9000	00 00 00 FC 00 34 32 53 4C 39 30 30 30 2D 5A 41 0A 20
42SL9500	00 00 00 FC 00 34 37 53 4C 39 30 30 30 2D 5A 41 0A 20

Checksum: Changeable by total EDID data.

Vendor Specific(HDMI)

INPUT	MODEL NAME(HEX)
HDMI1	67 03 0C 00 10 00 B8 2D
HDMI2	67 03 0C 00 20 00 B8 2D
HDMI3	67 03 0C 00 30 00 B8 2D
HDMI4	67 03 0C 00 40 00 B8 2D

## 4.5. Checking the function of Bluetooth

using adjusts Remote control

### (1) Auto checking

- Auto checking is doing in "Power Only".
- Checking the result of searched(check that is in list or not).
- Go out of checking mode pushing button "Exit".

### (2) Manual checking

- Push the button "Power Only" and "Exit".
- Push the button hot key "Bluetooth".
- Checking the result of searched(check that is in list or not).
- Go out of checking mode pushing button "Exit".



## 4.6. Outgoing condition Configuration

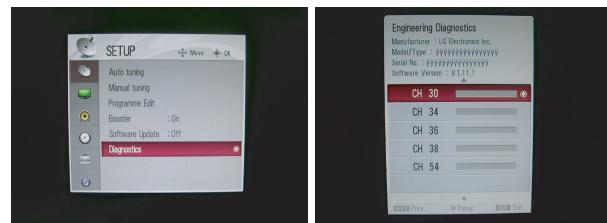
- When pressing "IN-STOP" key by Service remote control, Red LED are blinked alternatively. And then Automatically turn off. (Must not AC power OFF during blinking)

## 4.7. Internal pressure

Confirm whether is normal or not when between power board's ac block and GND is impacted on 1.5kV(dc) or 2.2kV(dc) for one second.

## 5. Serial number D/L

- Press "Power on" key of service remote control.  
(Baud rate : 115200 bps)
- Connect RS232 Signal Cable to RS-232 Jack.
- Write Serial number by use RS-232.
- Must check the serial number at the Diagnostics of SET UP menu. (Refer to below).



## 5.1. Signal TABLE

CMD	LENGTH	ADH	ADL	DATA_1	...	Data_n	CS	DELAY
-----	--------	-----	-----	--------	-----	--------	----	-------

CMD : A0h

LENGTH : 85~94h (1~16 bytes)

ADH : EEPROM Sub Address high (00~1F)

ADL : EEPROM Sub Address low (00~FF)

Data : Write data

CS : CMD + LENGTH + ADH + ADL + Data\_1 + ... + Data\_n

Delay : 20ms

## 5.2. Command Set

No.	Adjust mode	CMD(hex)	LENGTH(hex)	Description
1	EEPROM WRITE	A0h	84h+n	n-bytes Write (n = 1~16)

\* Description

FOS Default write : <7mode data> write

Vtotal, V\_Frequency, Sync\_Polarity, Htotal, Hstart, Vstart, 0, Phase

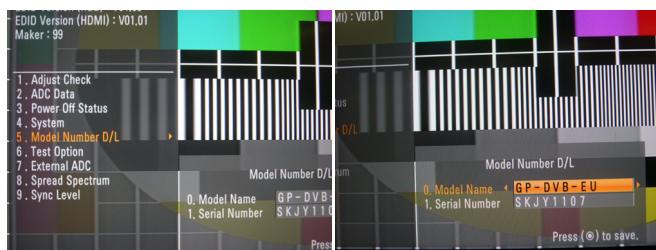
Data write : Model Name and Serial Number write in EEPROM.

## 5.3. Method & notice

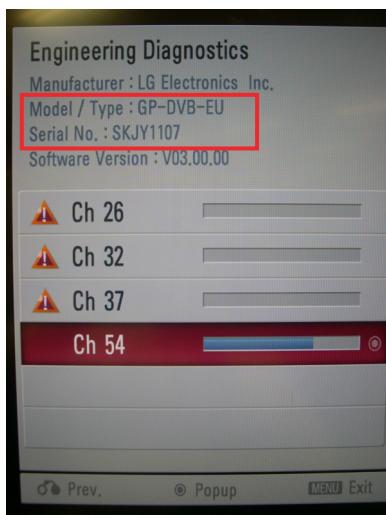
- Serial number D/L is using of scan equipment.
- Setting of scan equipment operated by Manufacturing Technology Group.
- Serial number D/L must be conformed when it is produced in production line, because serial number D/L is mandatory by D-book 4.0.

\* Manual Download (Model Name and Serial Number)  
 If the TV set is downloaded by OTA or Service man, sometimes  
 model name or serial number is initialized.(Not always)  
 There is impossible to download by bar code scan, so It  
 need Manual download.

- 1) Press the 'Instart' key of ADJ remote control.
- 2) Go to the menu '5.Model Number D/L' like below photo.
- 3) Input the Factory model name(ex 42LH4000-ZA) or Serial  
 number like photo.

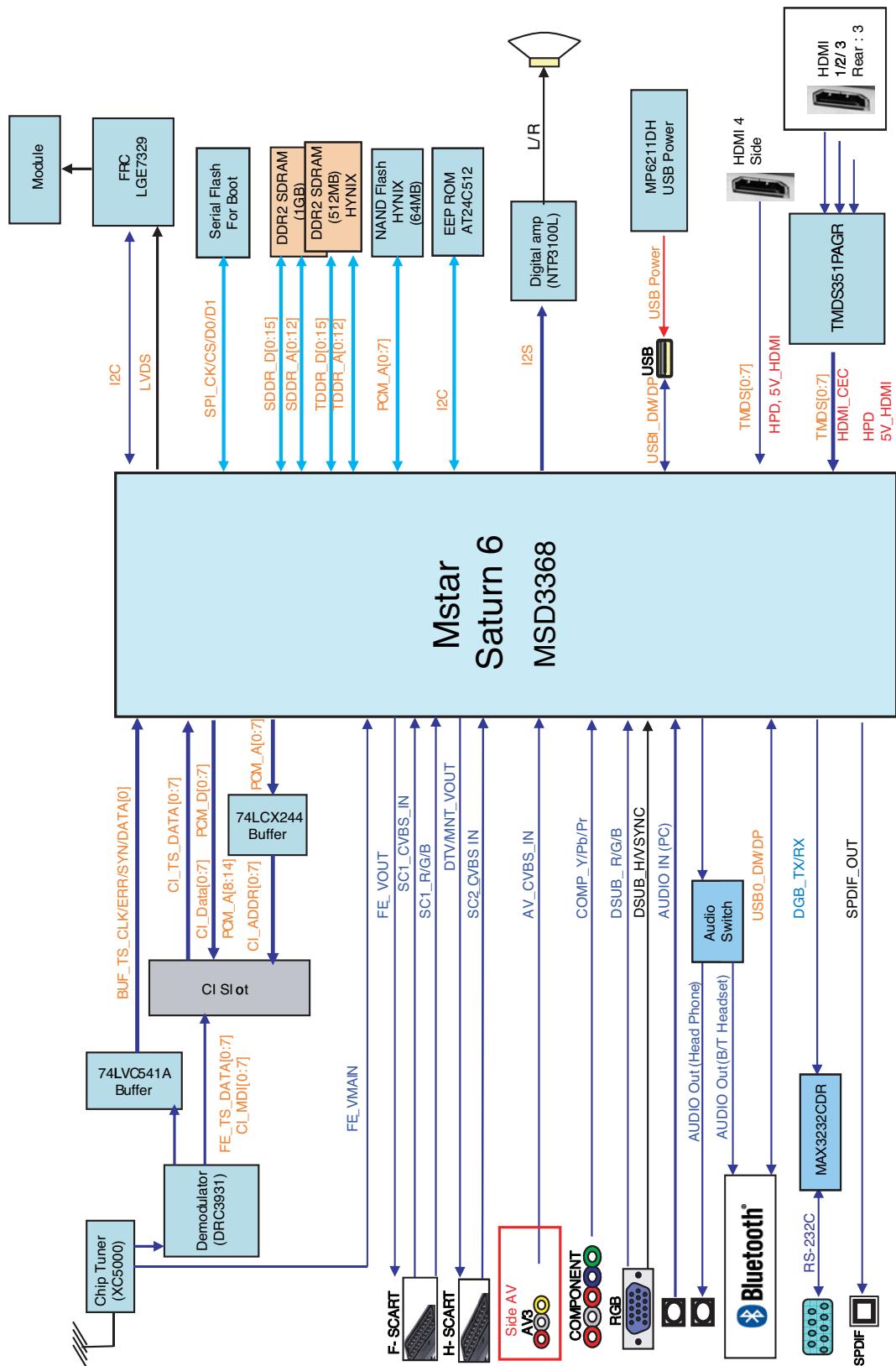


- 4) Check the model name Instart menu -> Factory name  
 displayed (ex 42SL8000-ZB)
- 5) Check the Diagnostics (DTV country only) -> Buyer model  
 displayed (ex 42SL8000-ZB)

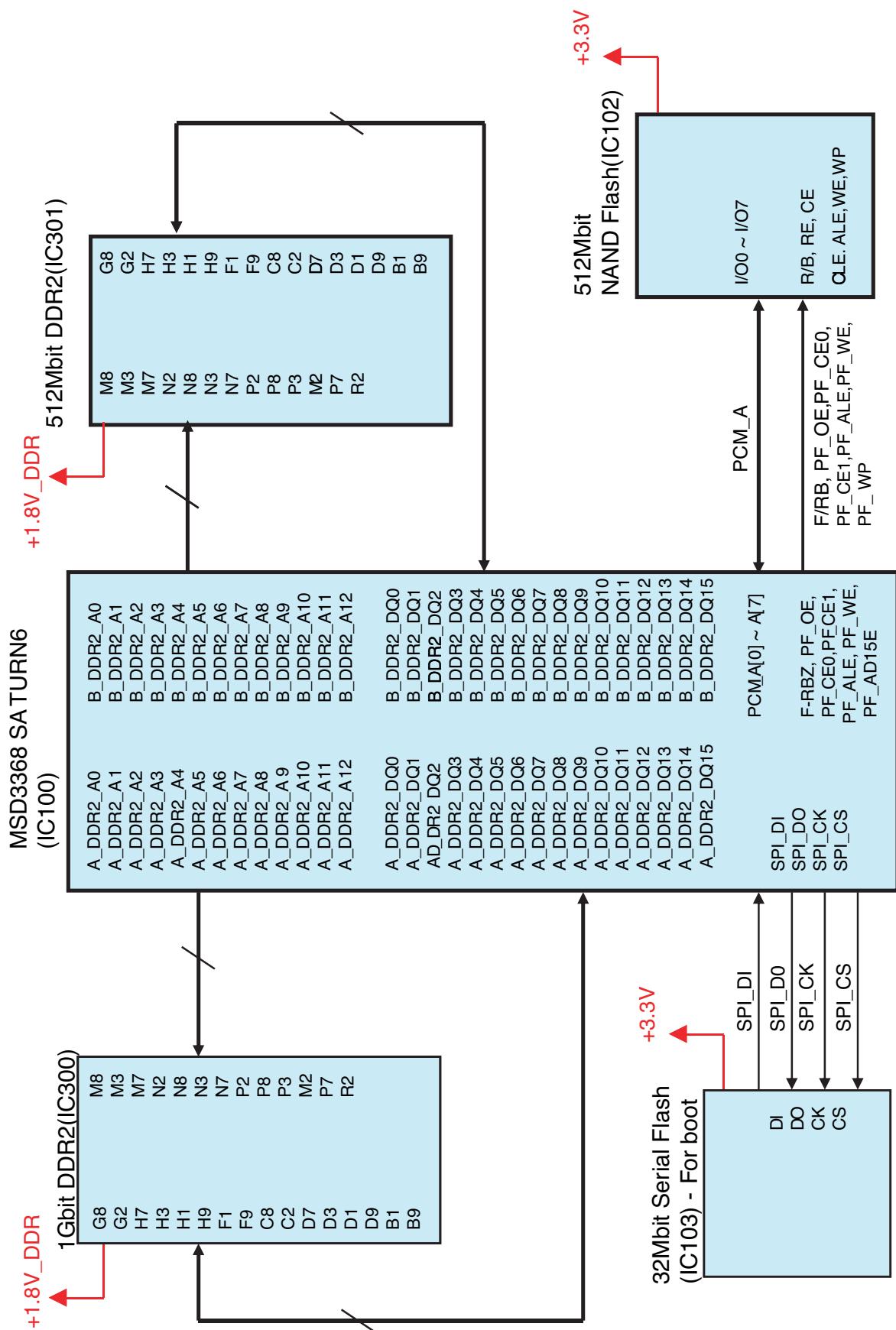


# BLOCK DIAGRAM

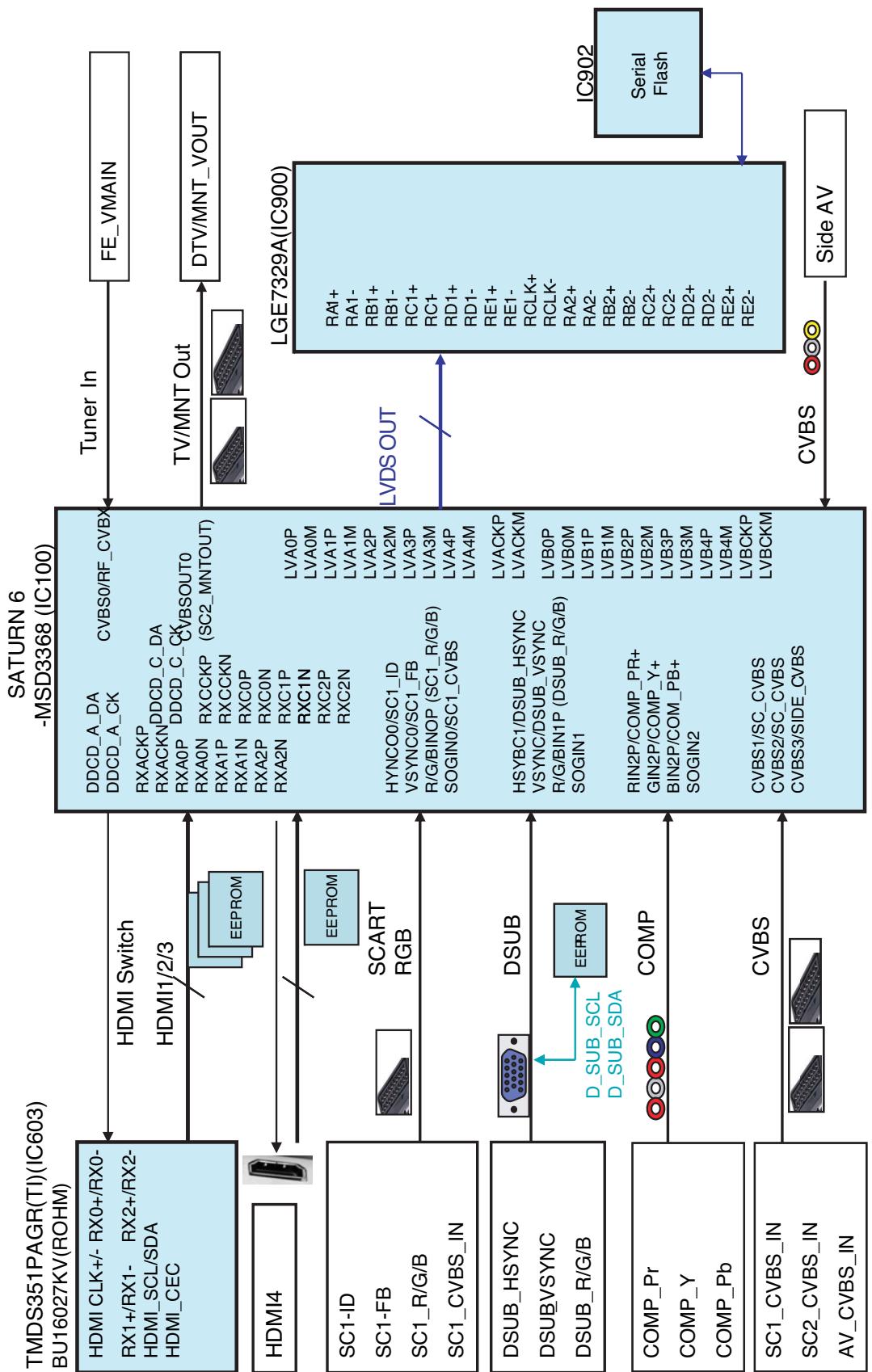
## 1. T-project



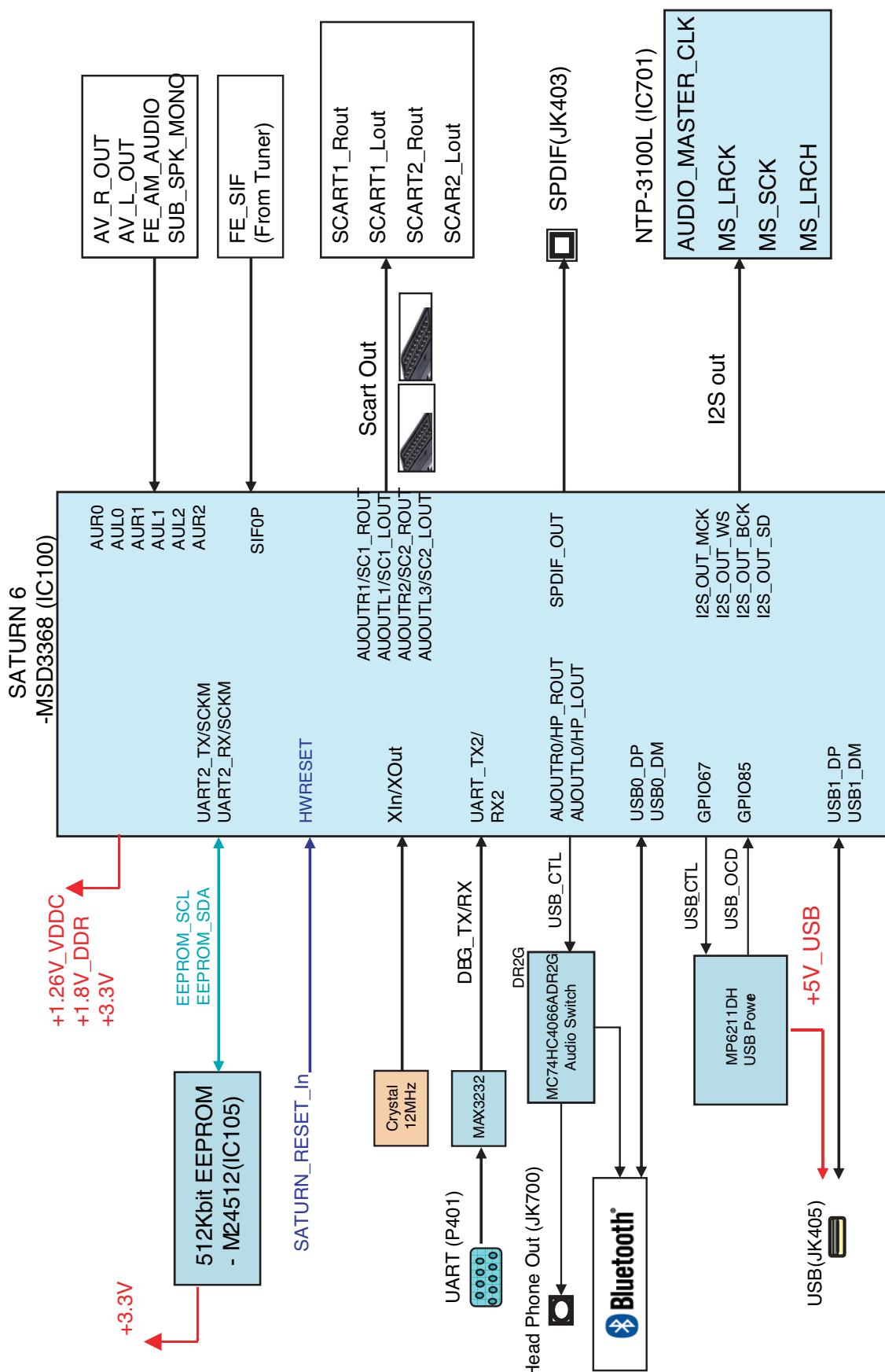
## 2. Memory



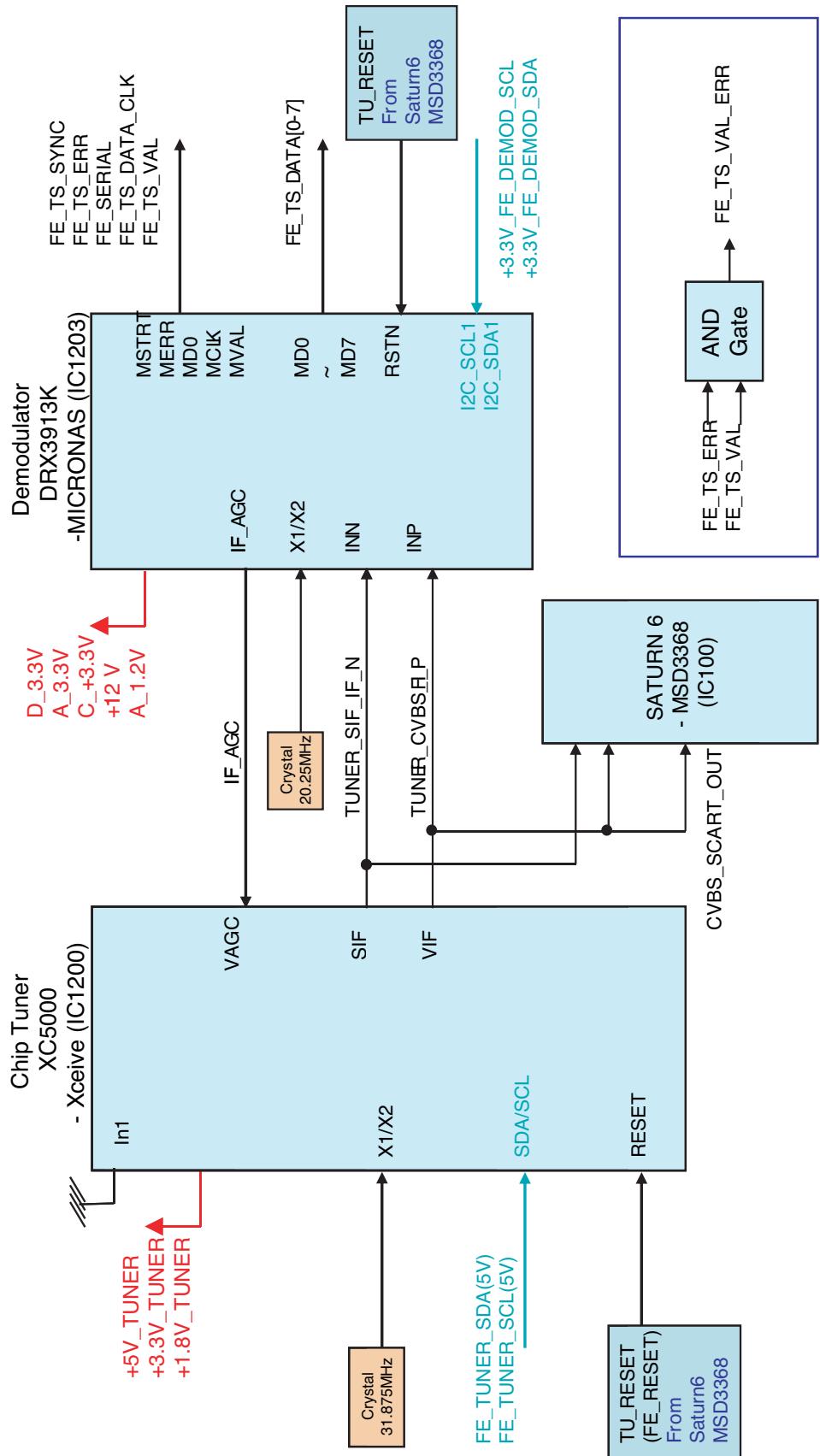
### 3. Video



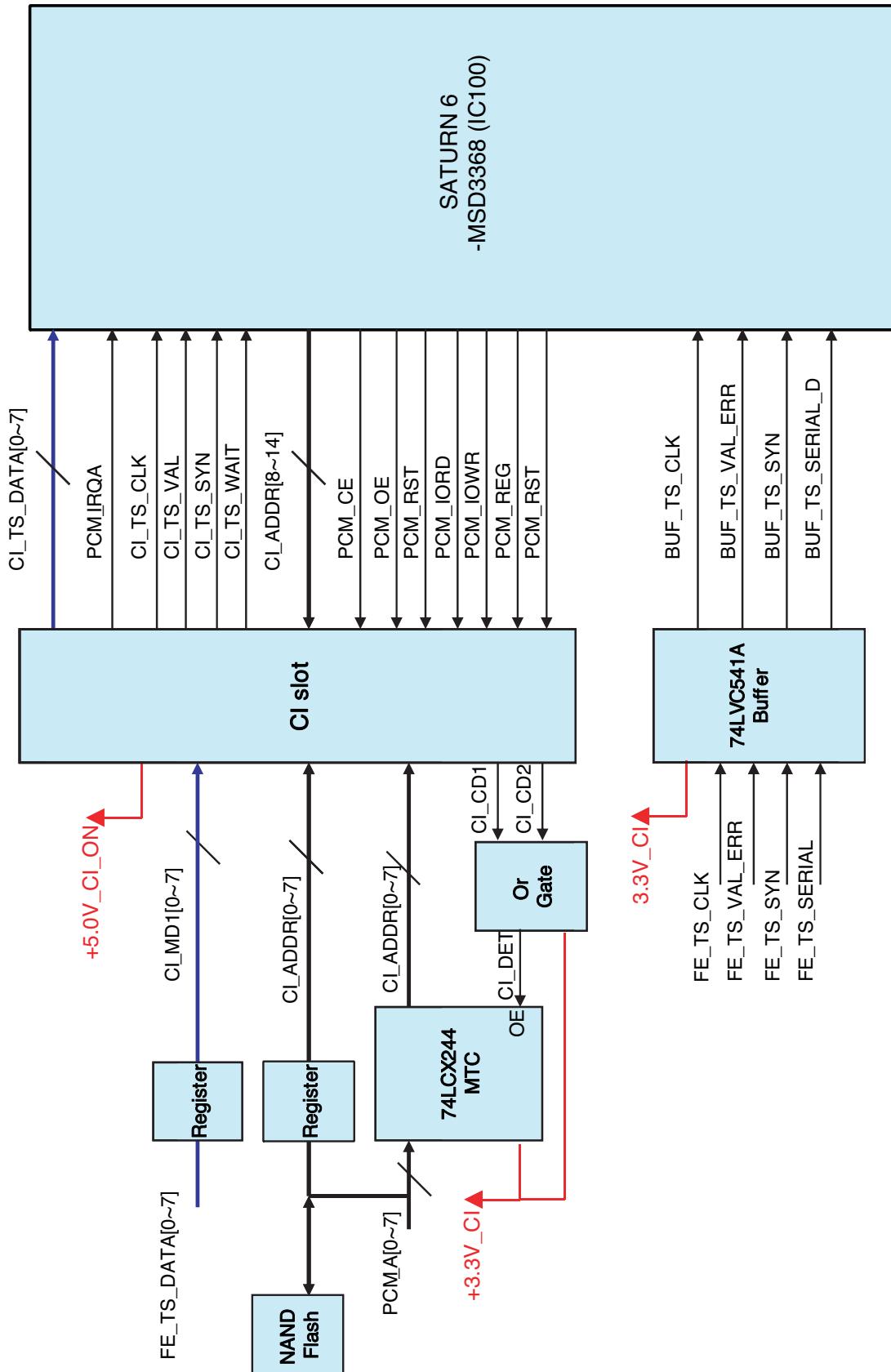
## 4. Audio & ETC



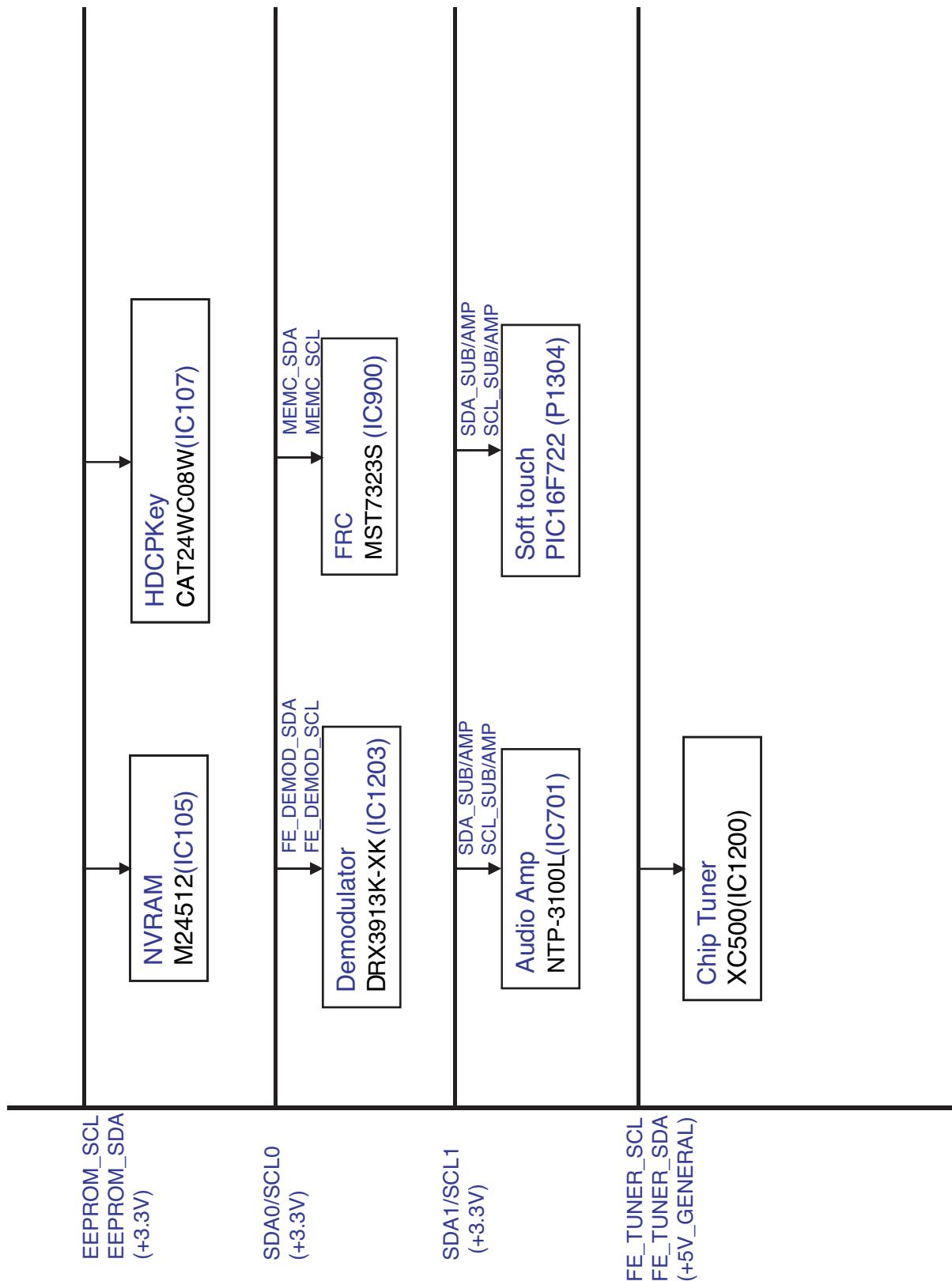
## 5. Tuner



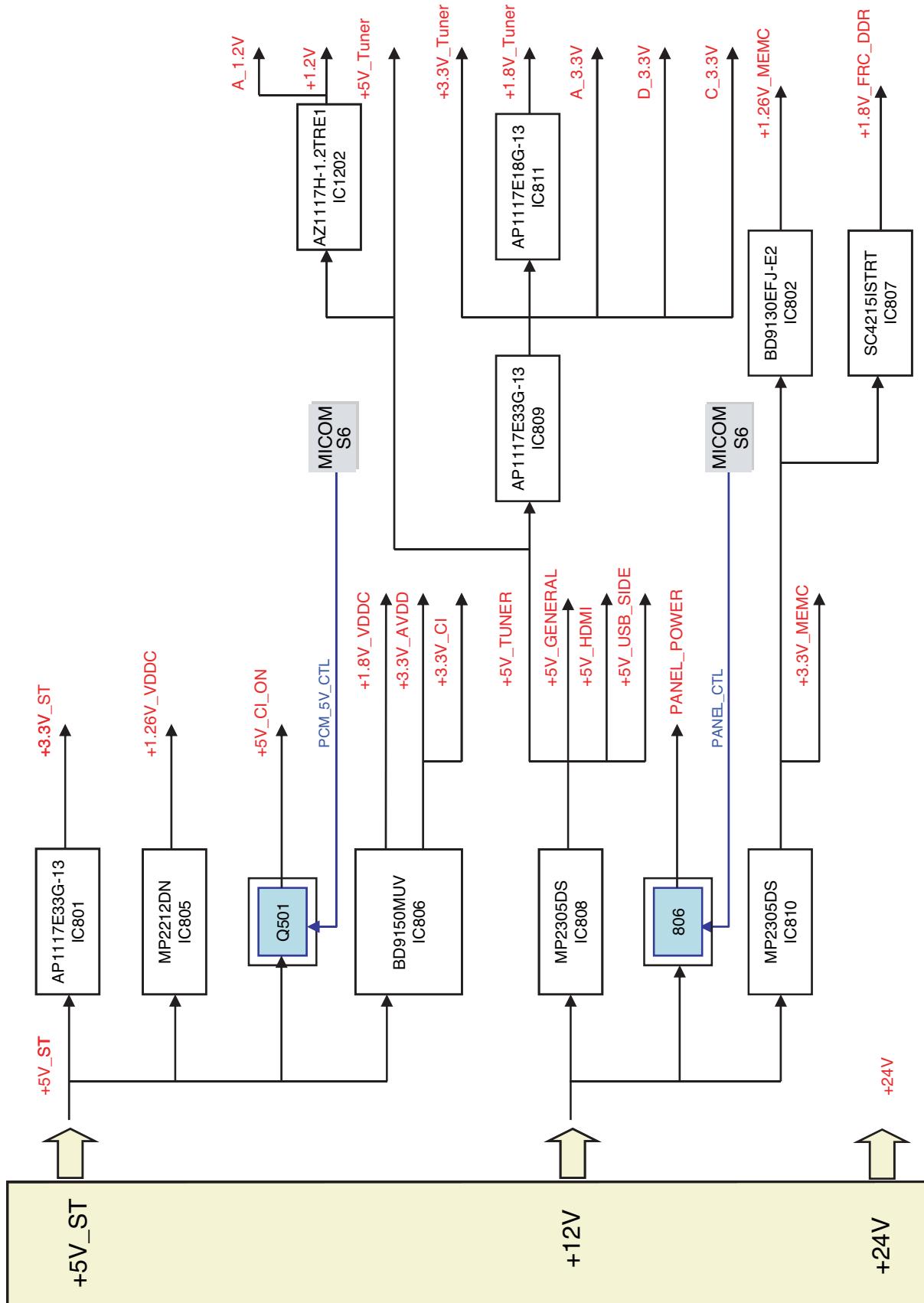
## 6. CI



## 7. I2C Map



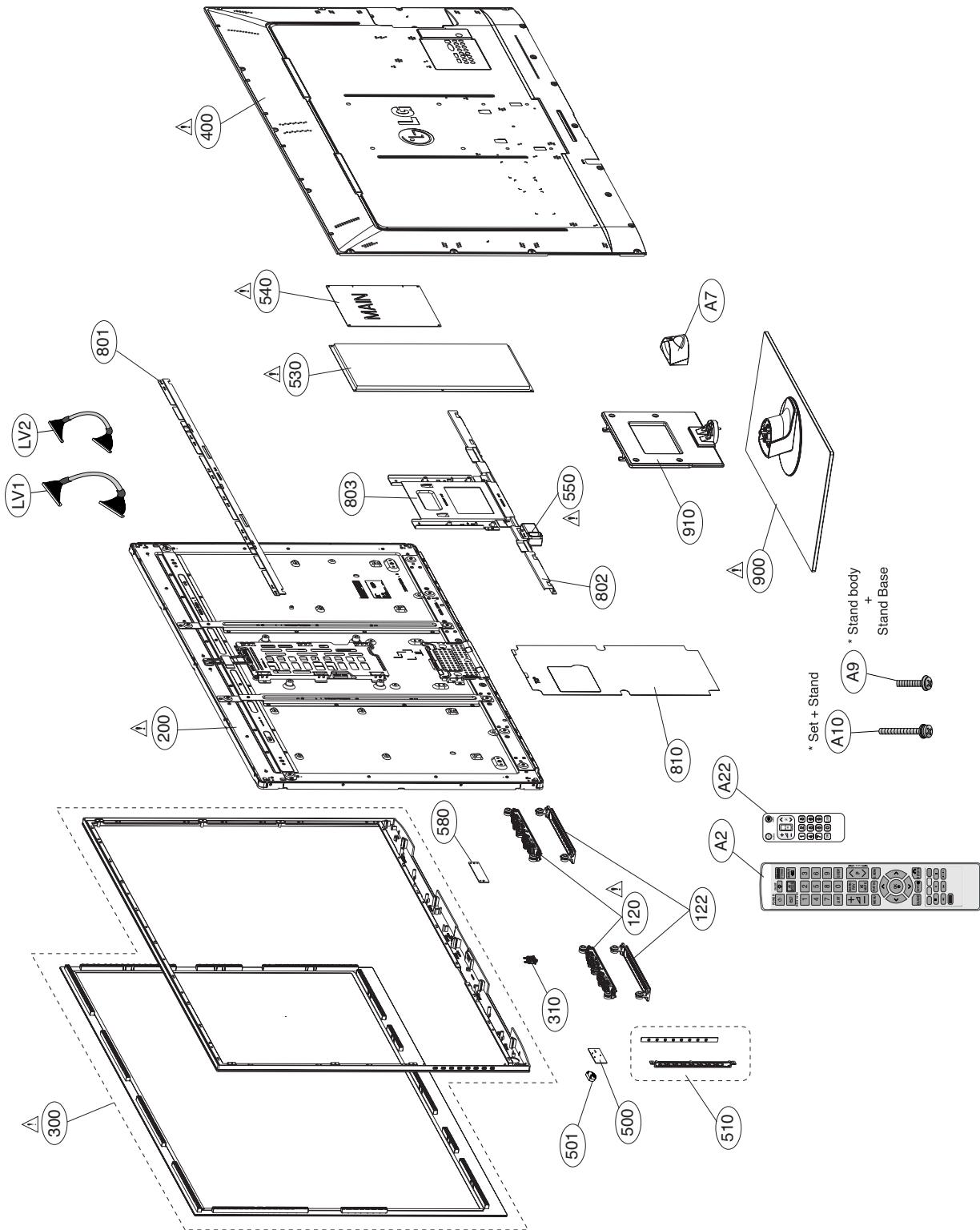
## 8. Power

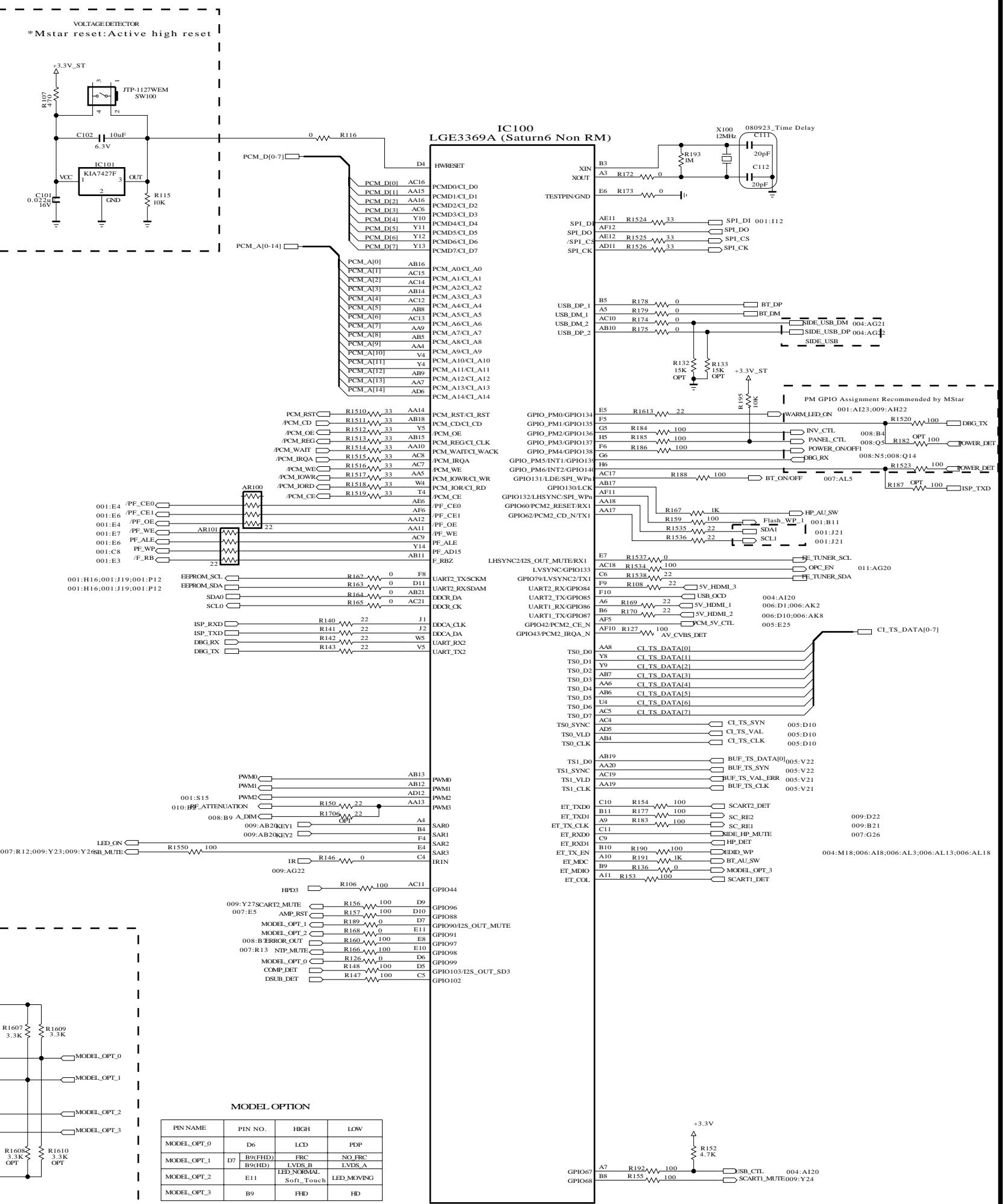
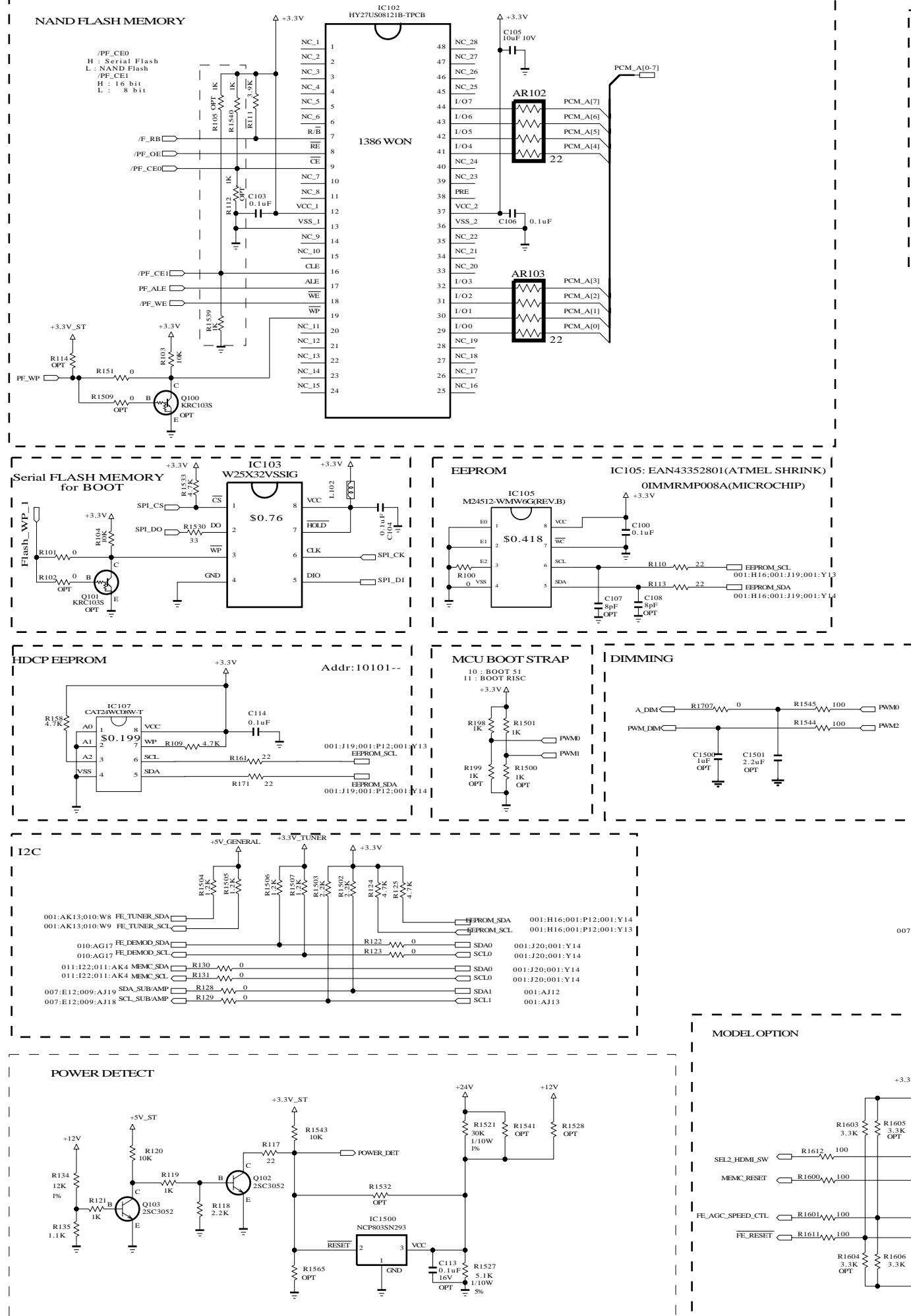


# EXPLODED VIEW

## IMPORTANT SAFETY NOTICE

Many electrical and mechanical parts in this chassis have special safety-related characteristics. These parts are identified by  $\triangle$  in the Schematic Diagram and EXPLODED VIEW.  
It is essential that these special safety parts should be replaced with the same components as recommended in this manual to prevent X-RADIATION, Shock, Fire, or other Hazards.  
Do not modify the original design without permission of manufacturer.

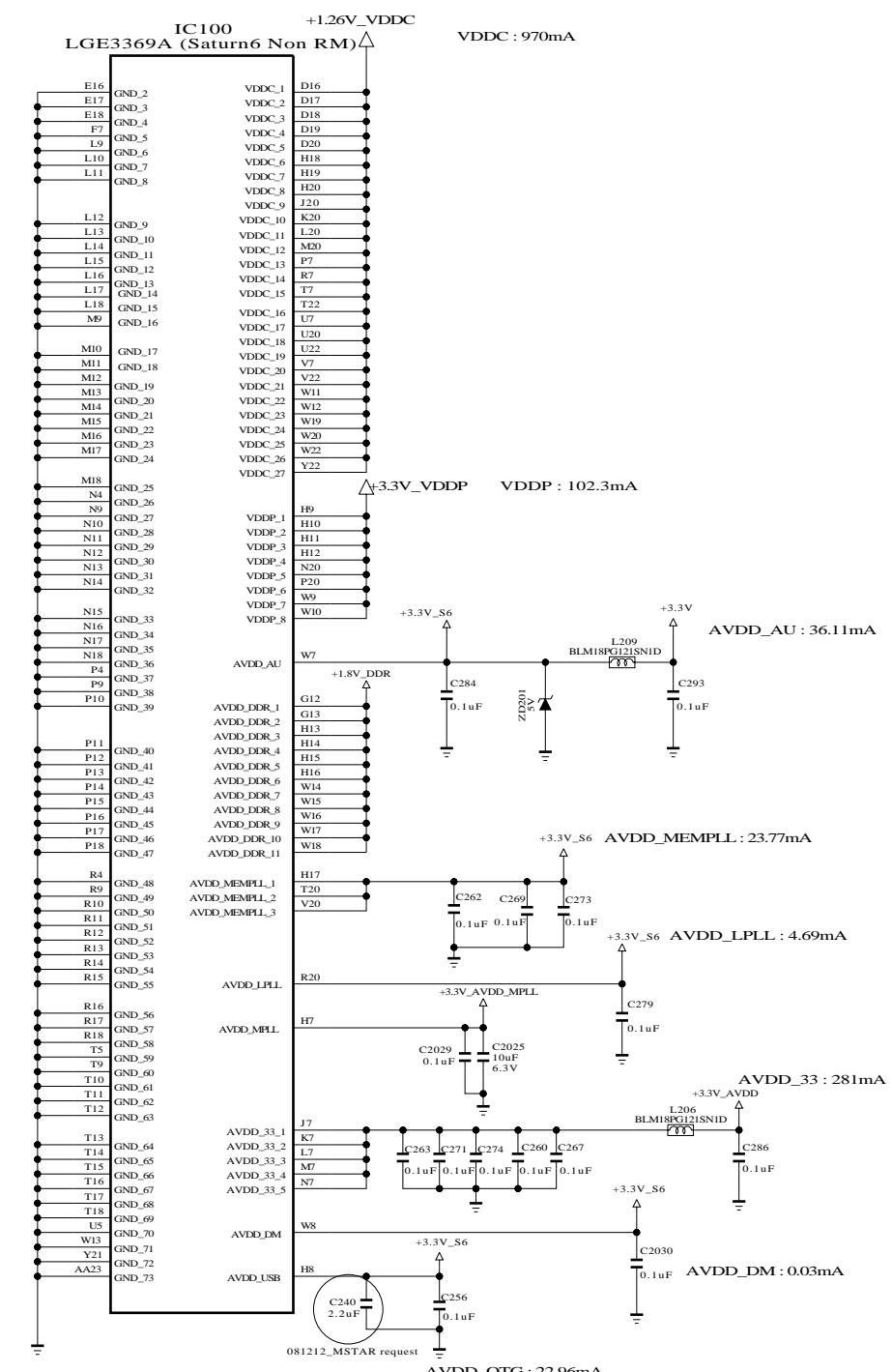
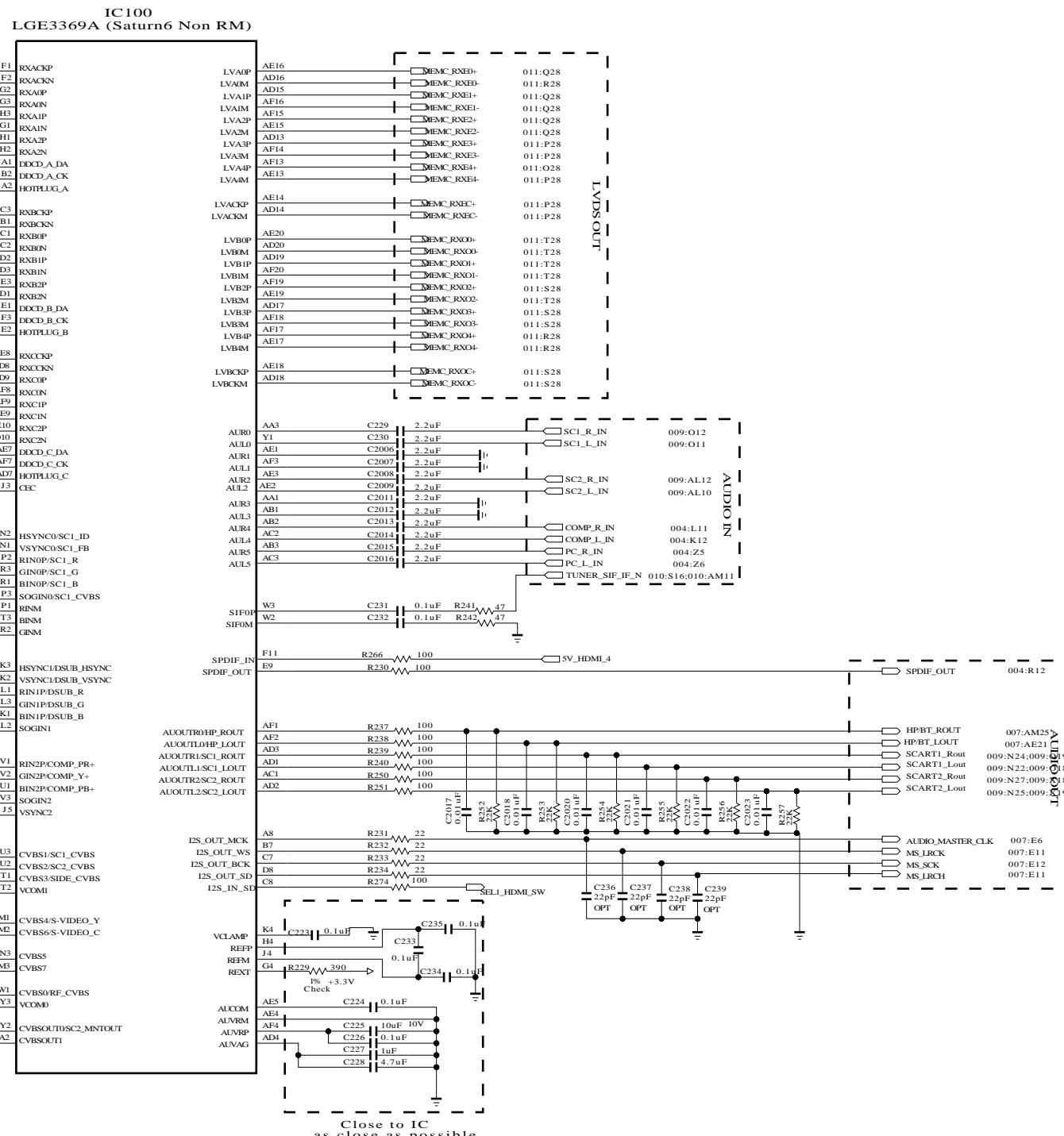
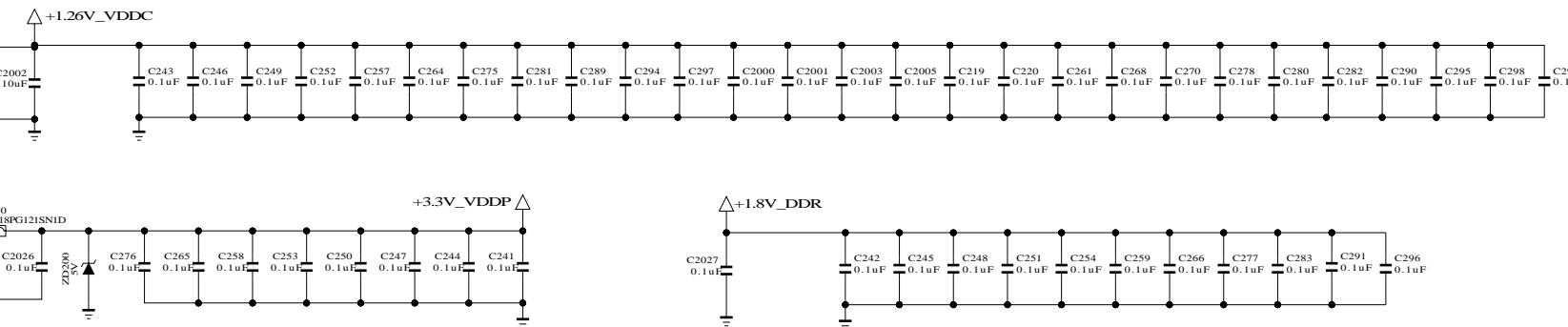




THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFATURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

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LG Electronics

LG ELECTRONICS

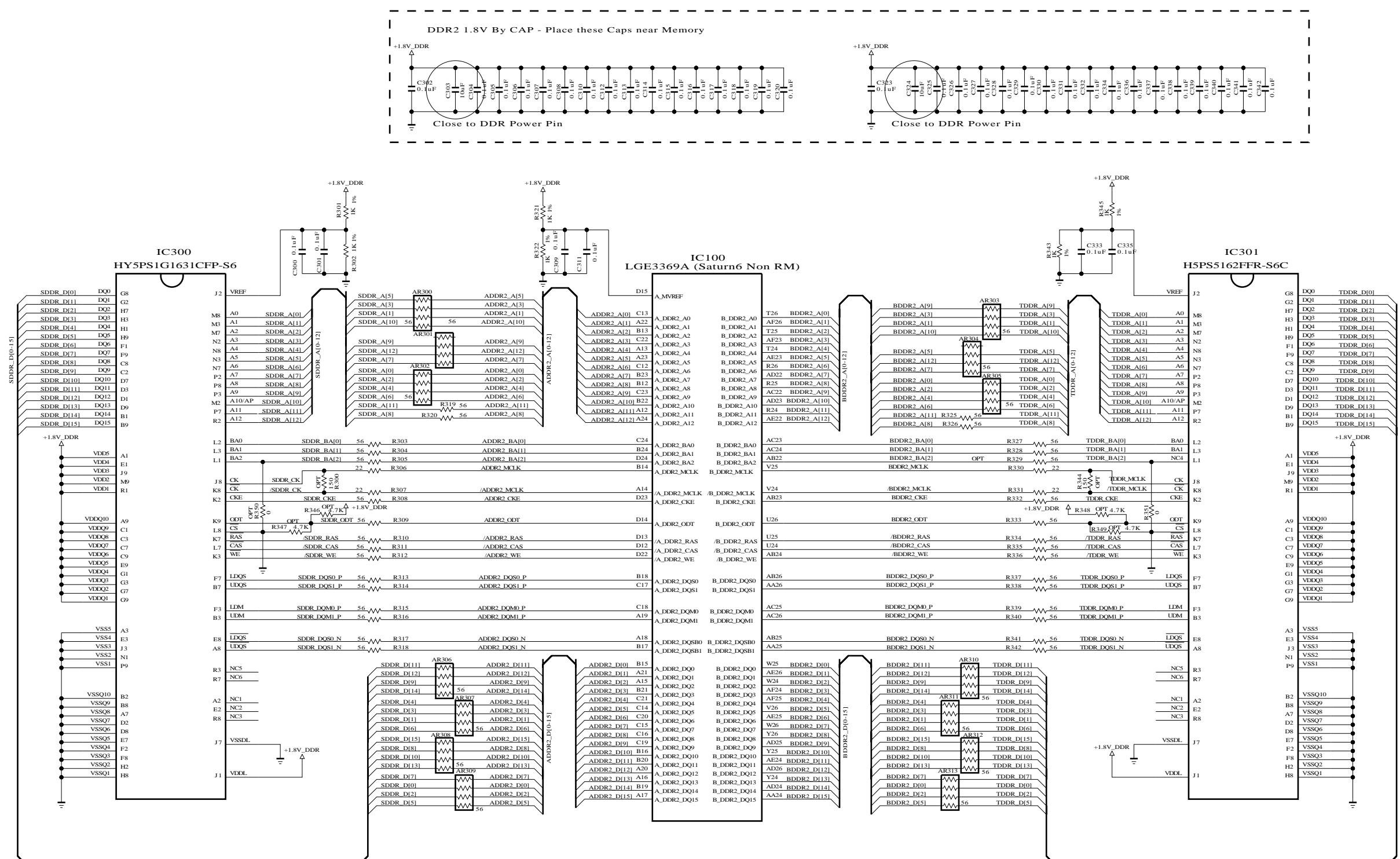


THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS. WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

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LG ELECTRONICS

MODEL	EAX60890801	DATE	2009.04.16
BLOCK	MAIN_2	SHEET	2 / 12



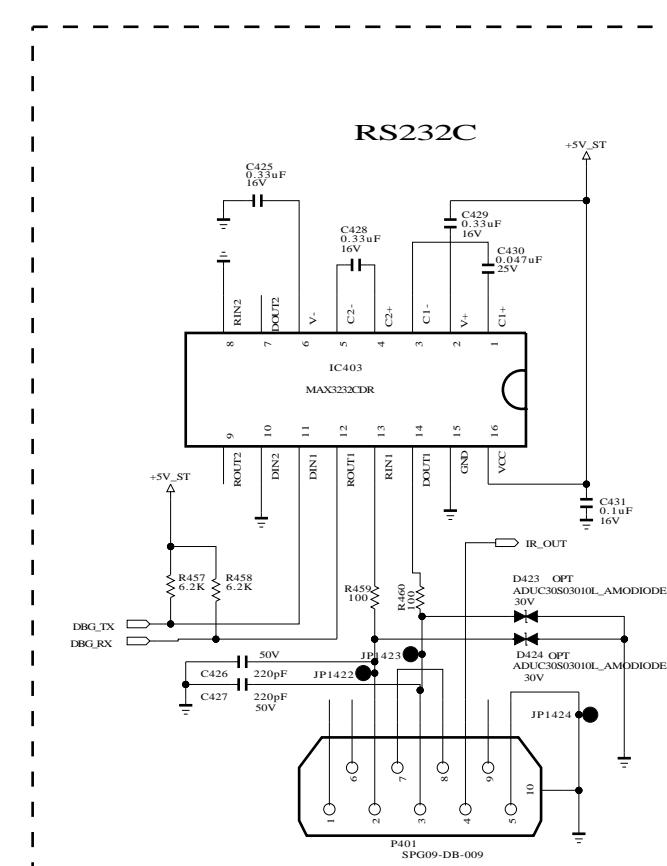
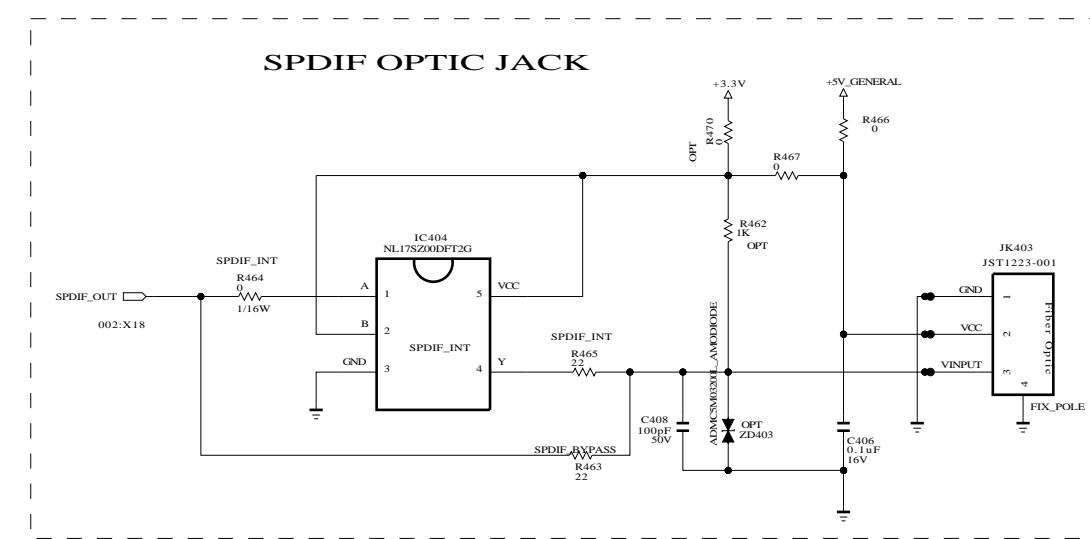
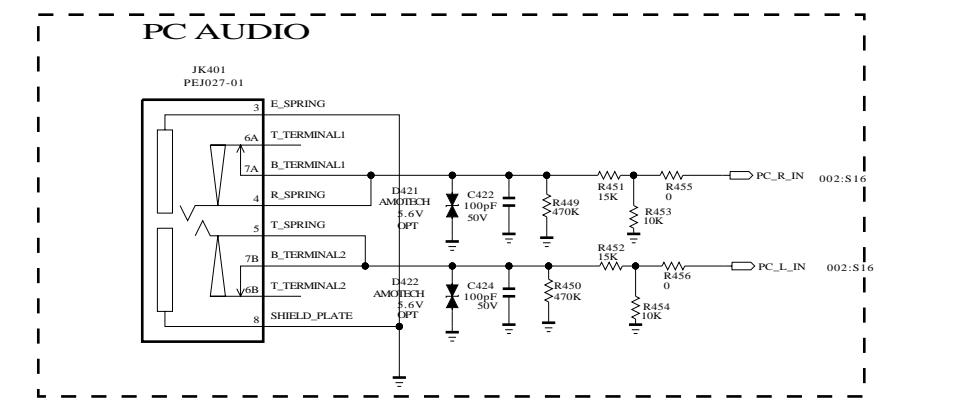
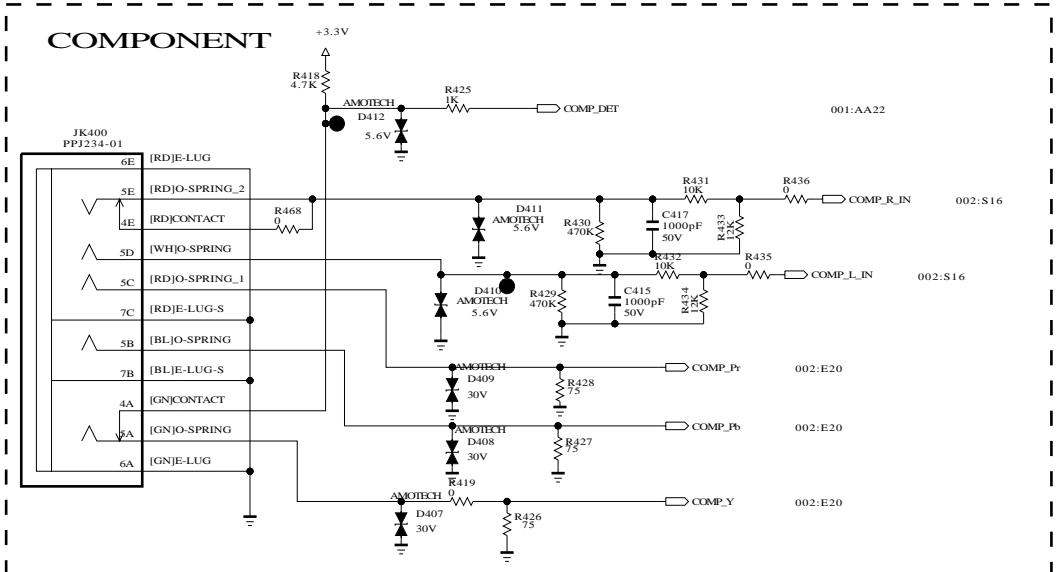
THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION, FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

SECRET



 LG ELECTRONICS

MODEL	EAX60890801	DATE	2009.04.16
BLOCK	DDR2	SHEET	3 / 12

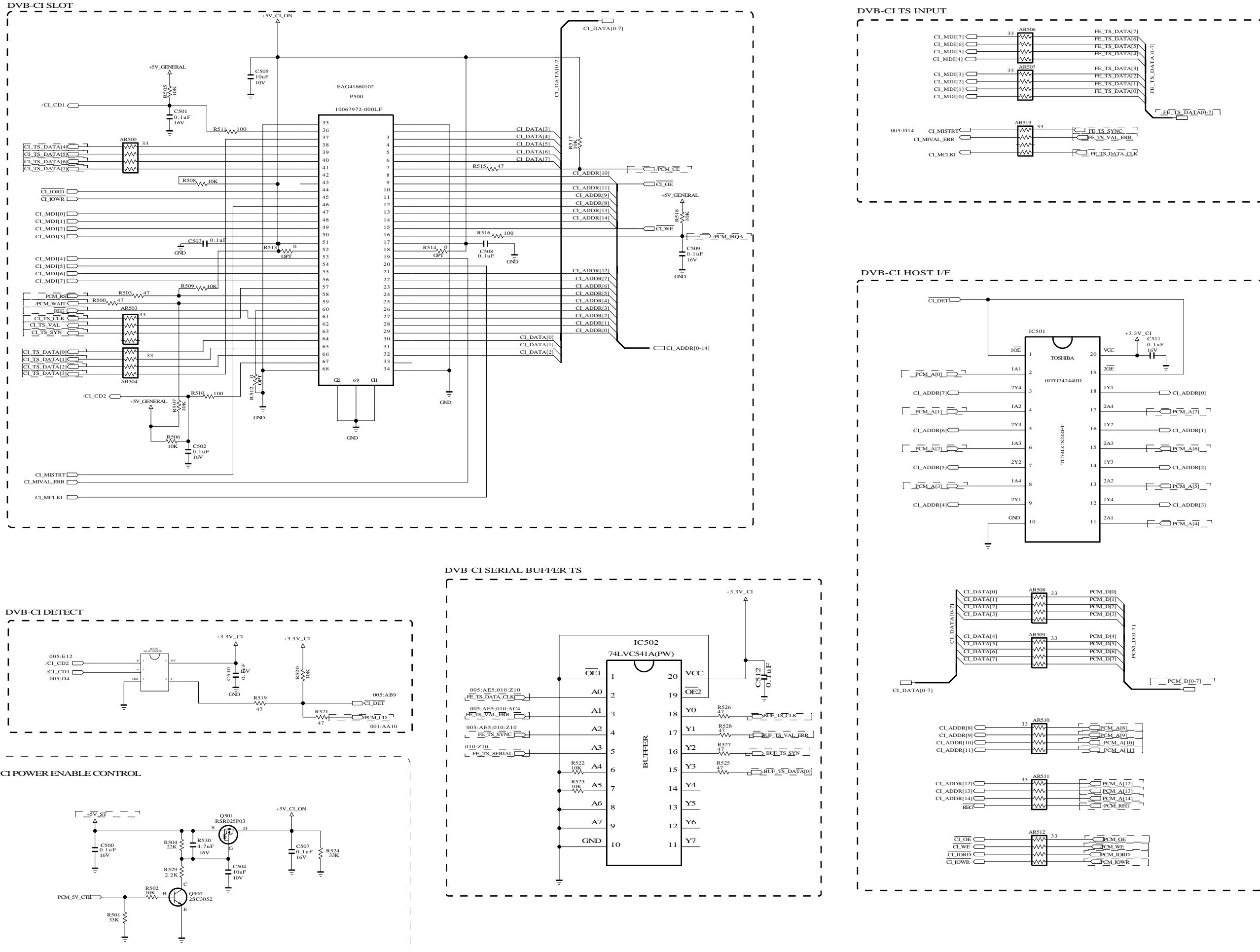


THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS. WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

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LG ELECTRONICS

MODEL	EAX60890801	DATE	2009.04.16
BLOCK	INTERFACE	SHEET	4 / 12

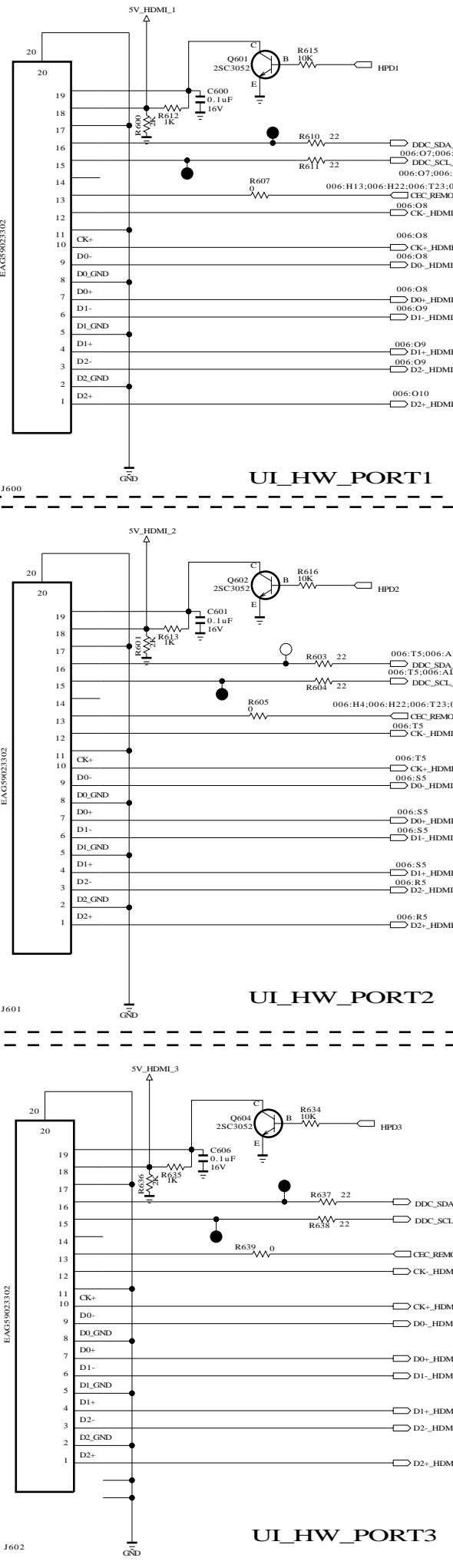
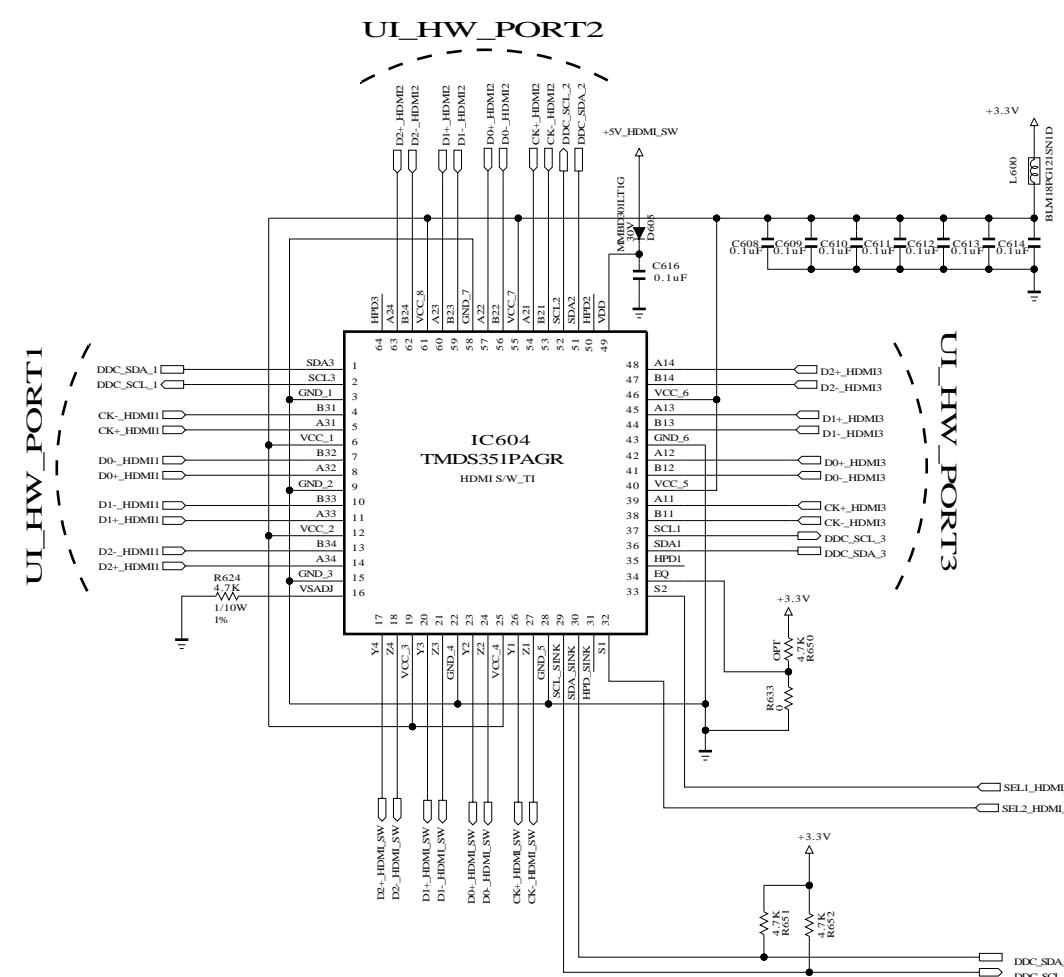
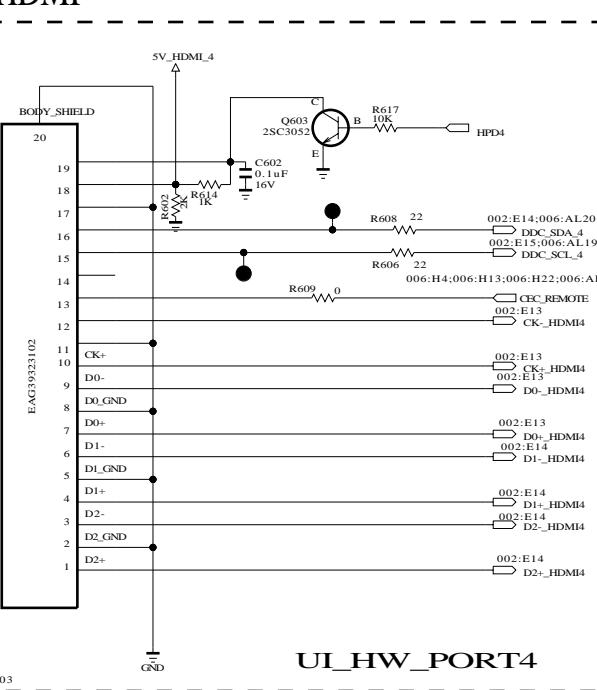
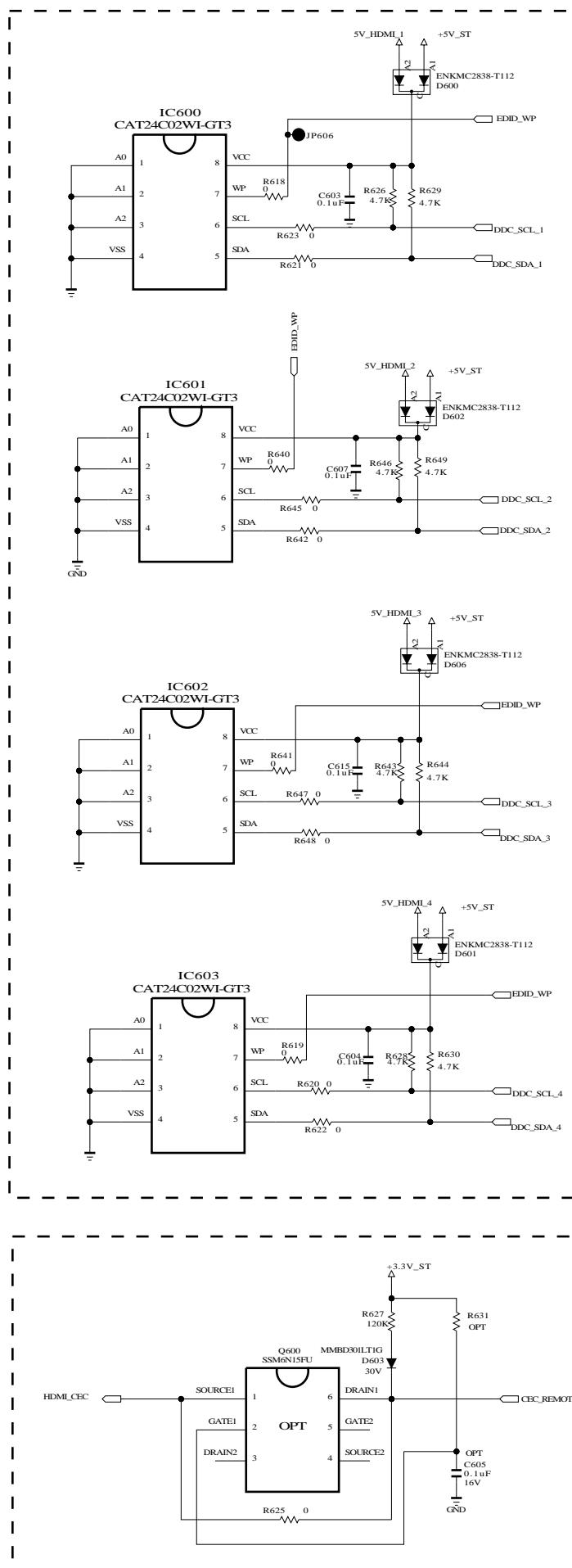


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MODEL	EAX60890801	DATE	2009.04.16
BLOCK	PCMCIA	SHEET	5 / 12

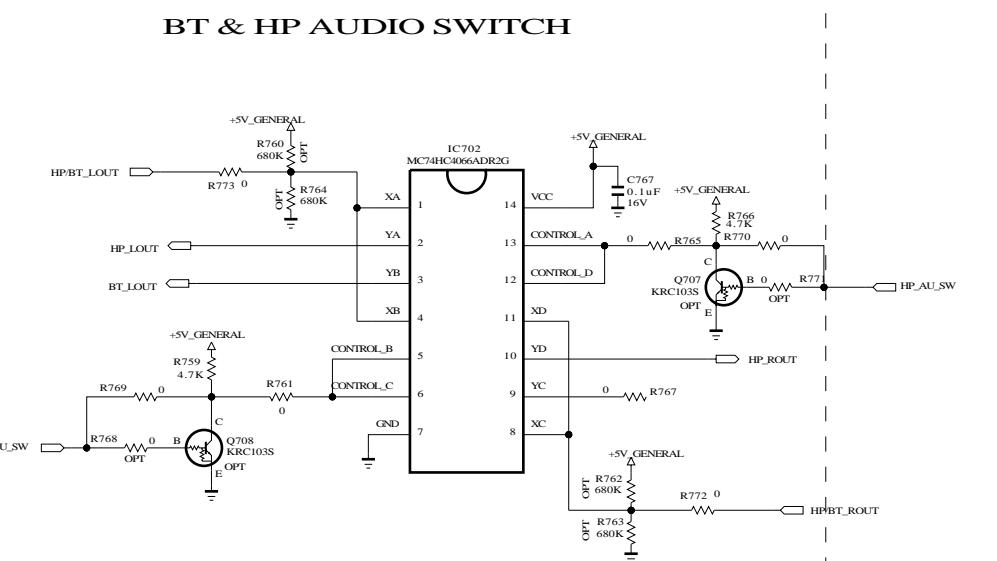
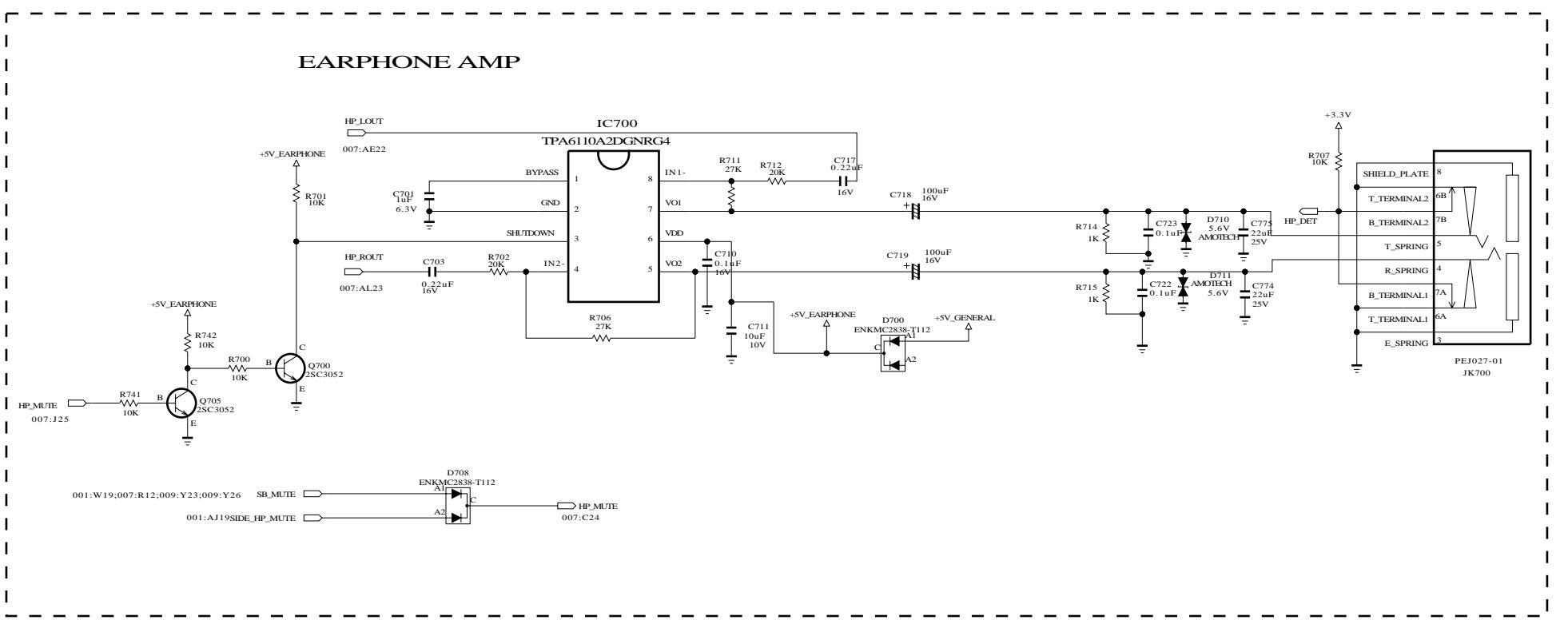
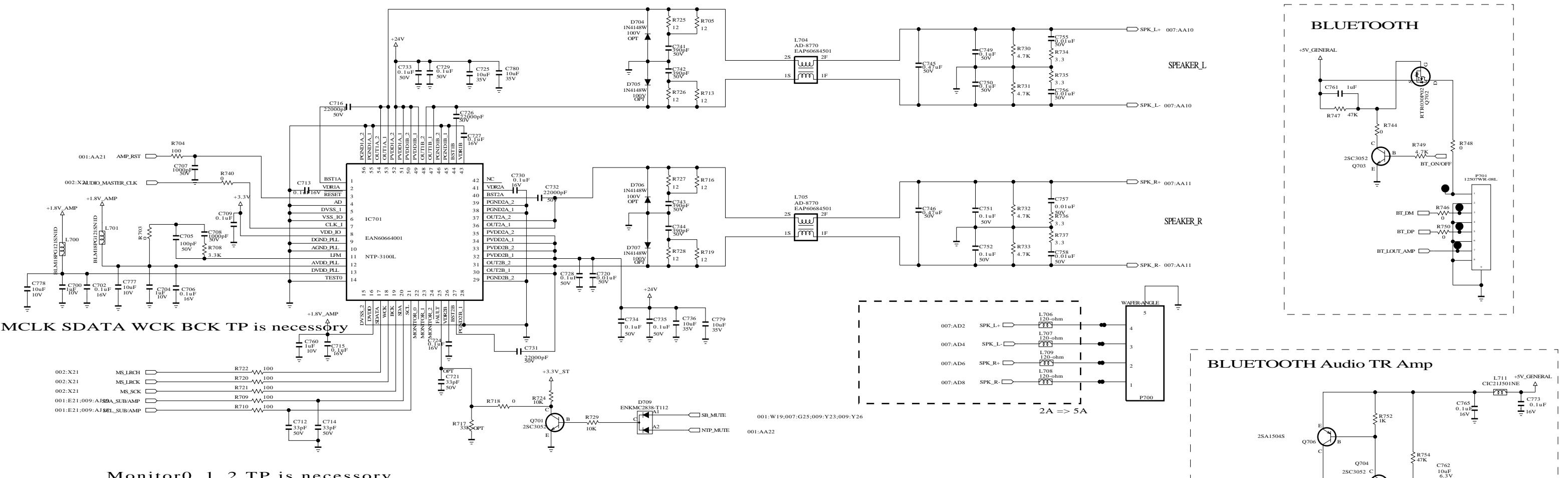
**SIDE HDMI****HDMI EEPROM**

THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FIRE AND ELECTRICAL SHOCK HAZARDS. WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

**SECRET**  
LG Electronics

**LG ELECTRONICS**

<b>MODEL</b>	EAX60890801	<b>DATE</b>	2009.04.16
<b>BLOCK</b>	HDMI	<b>SHEET</b>	6 / 12



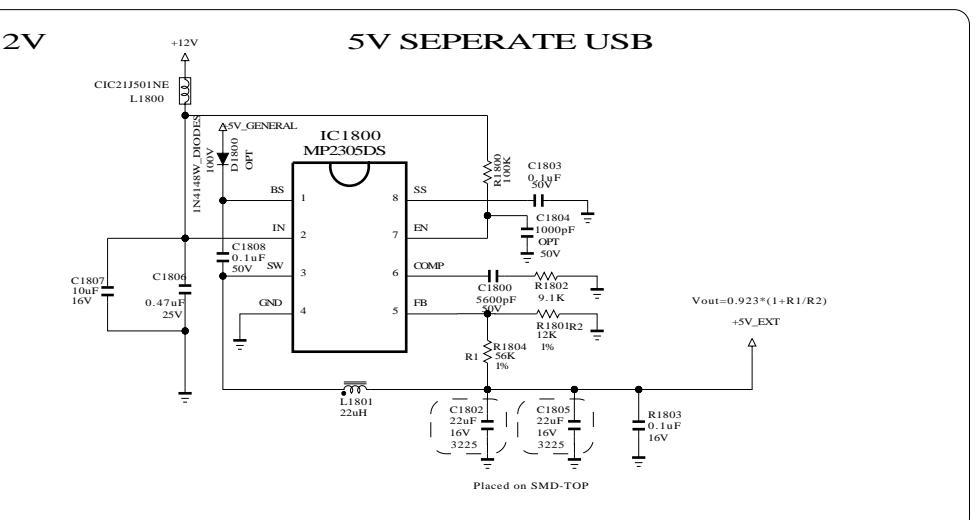
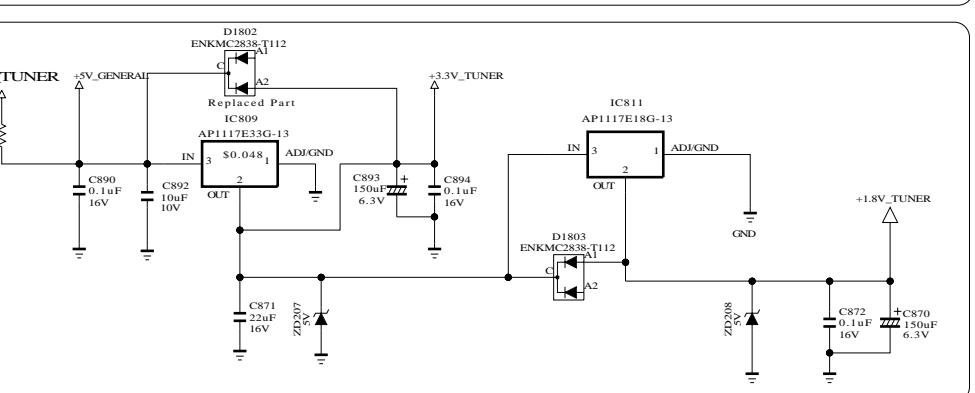
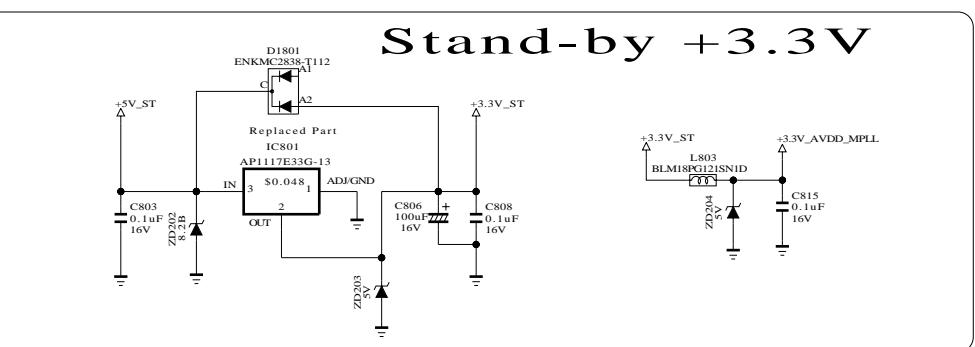
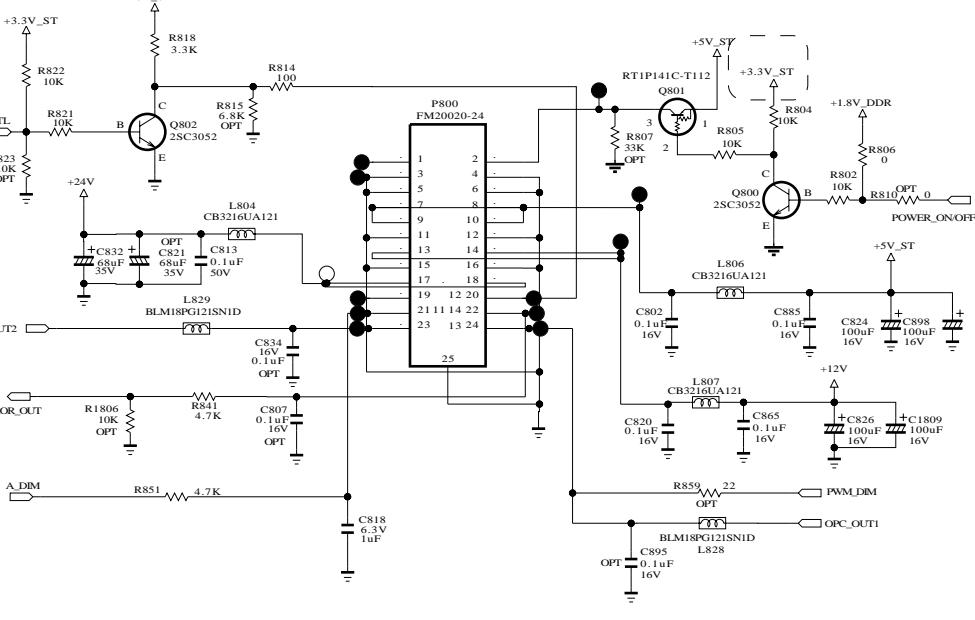
THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

**SECRET**  
LG Electronics

LG ELECTRONICS

MODEL	EAX60890801	DATE	2009.04.16
BLOCK	AMP	SHEET	7 / 12

# FROM LIPS & POWER B/D

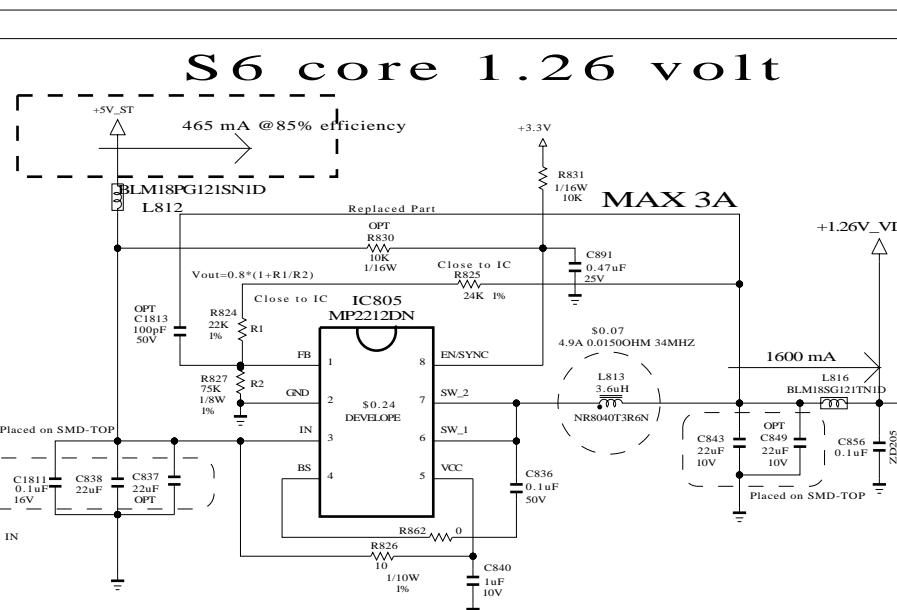
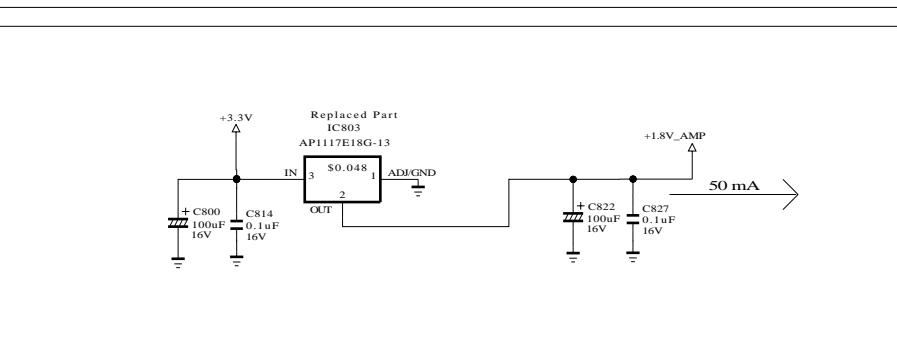
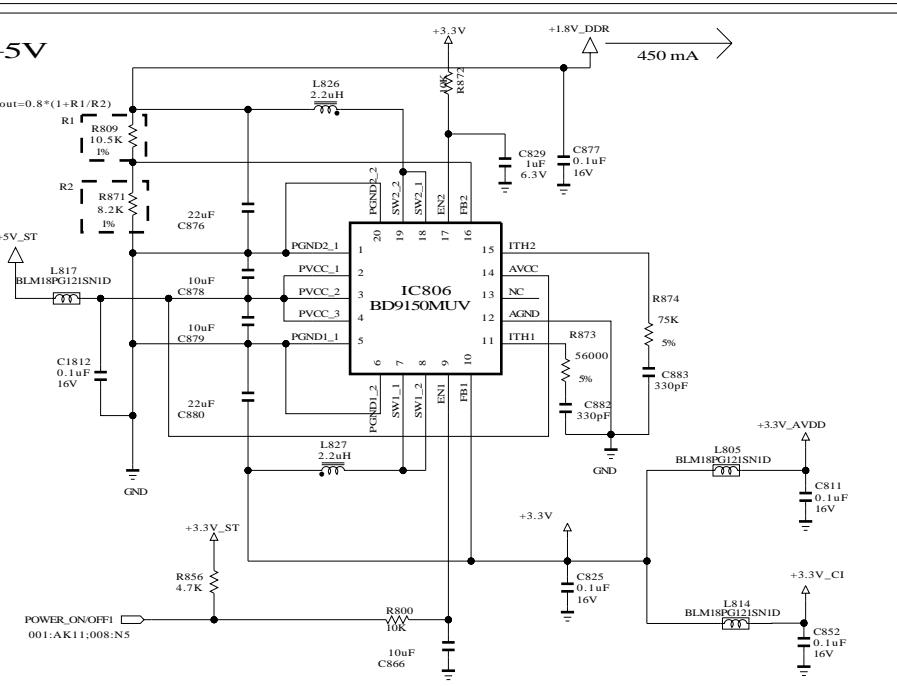
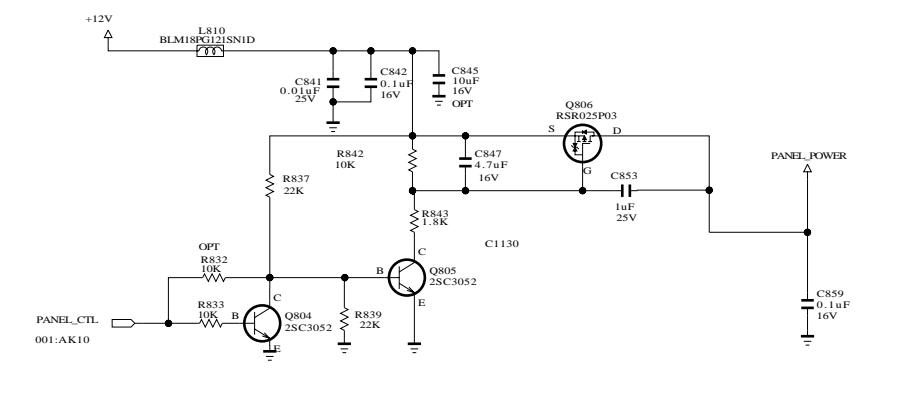


THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

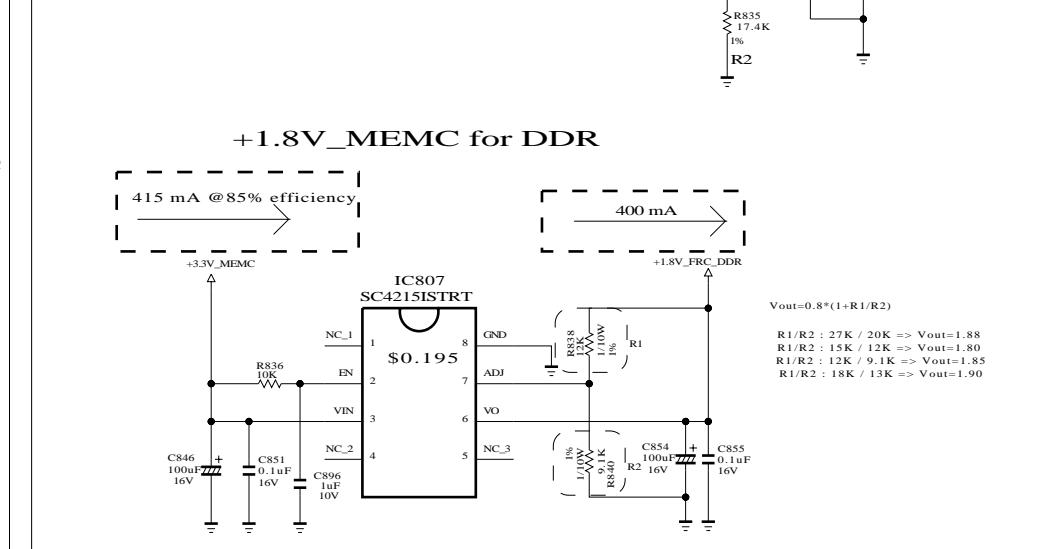
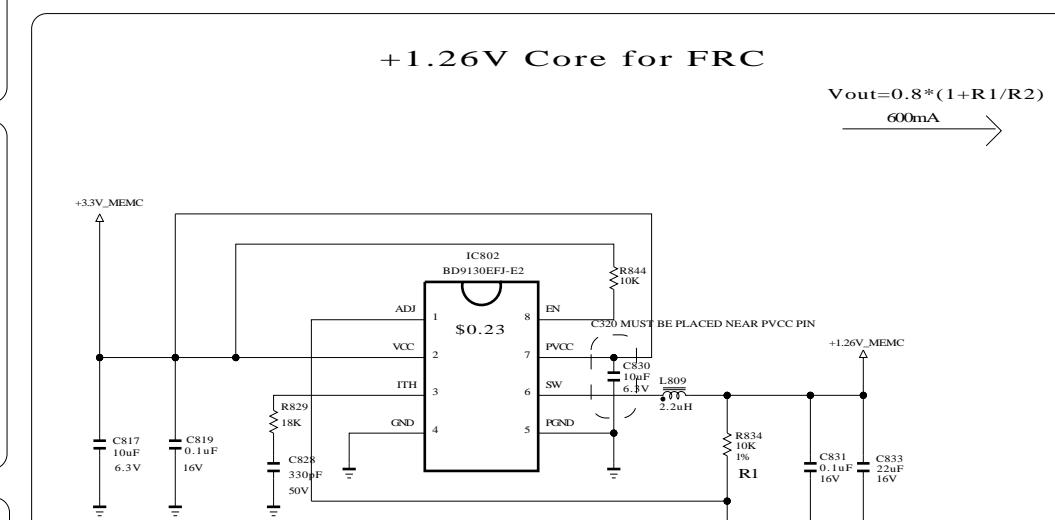
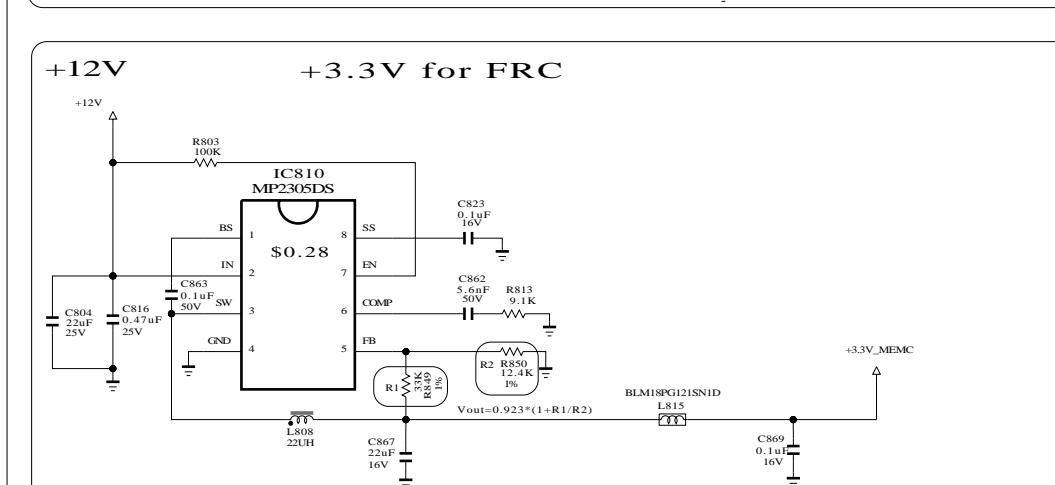
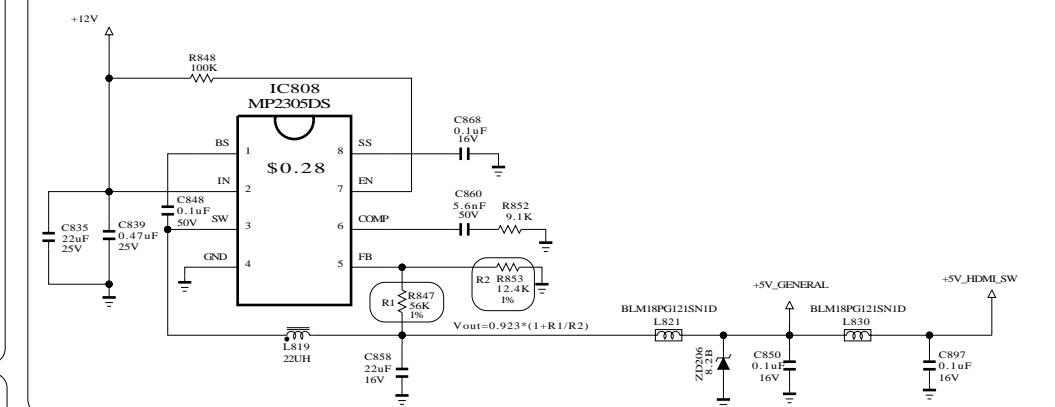
**SECRET**  
LG Electronics

LG ELECTRONICS

# +12V



# +12V



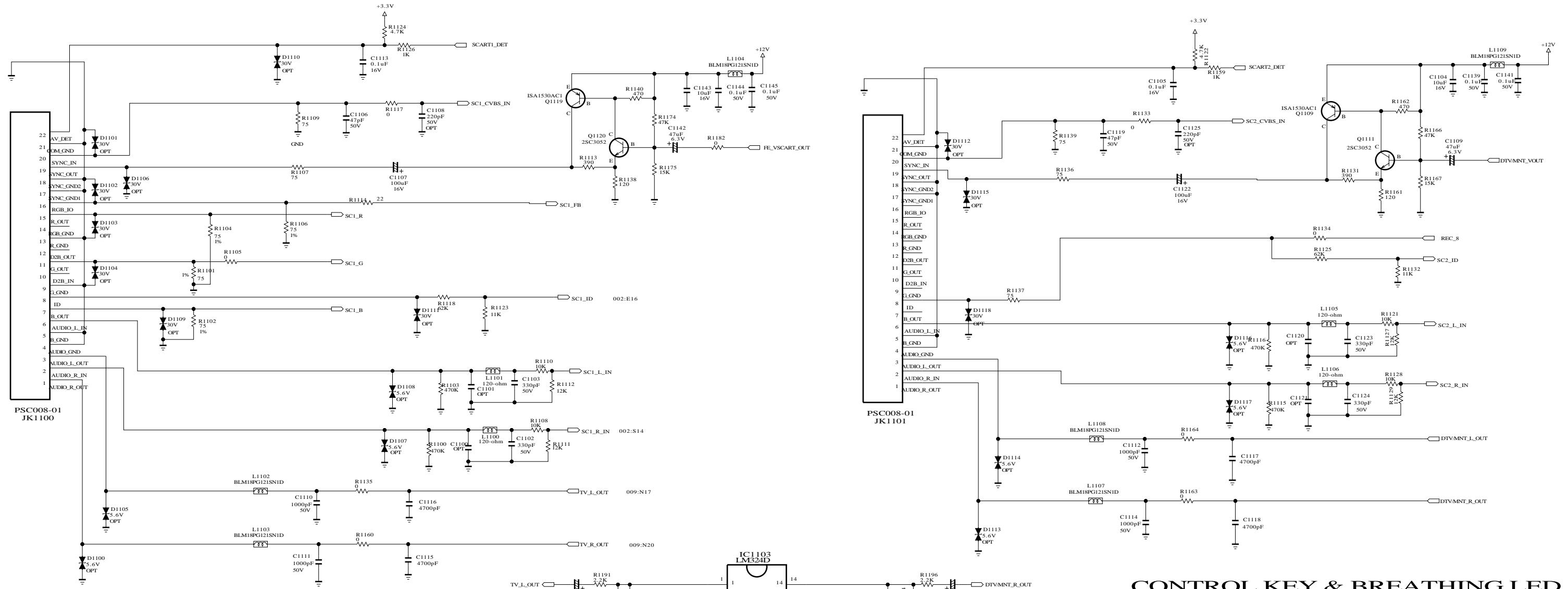
Vout=0.8\*(1+R1/R2)

R1/R2 : 15K / 13K => Vout=1.88

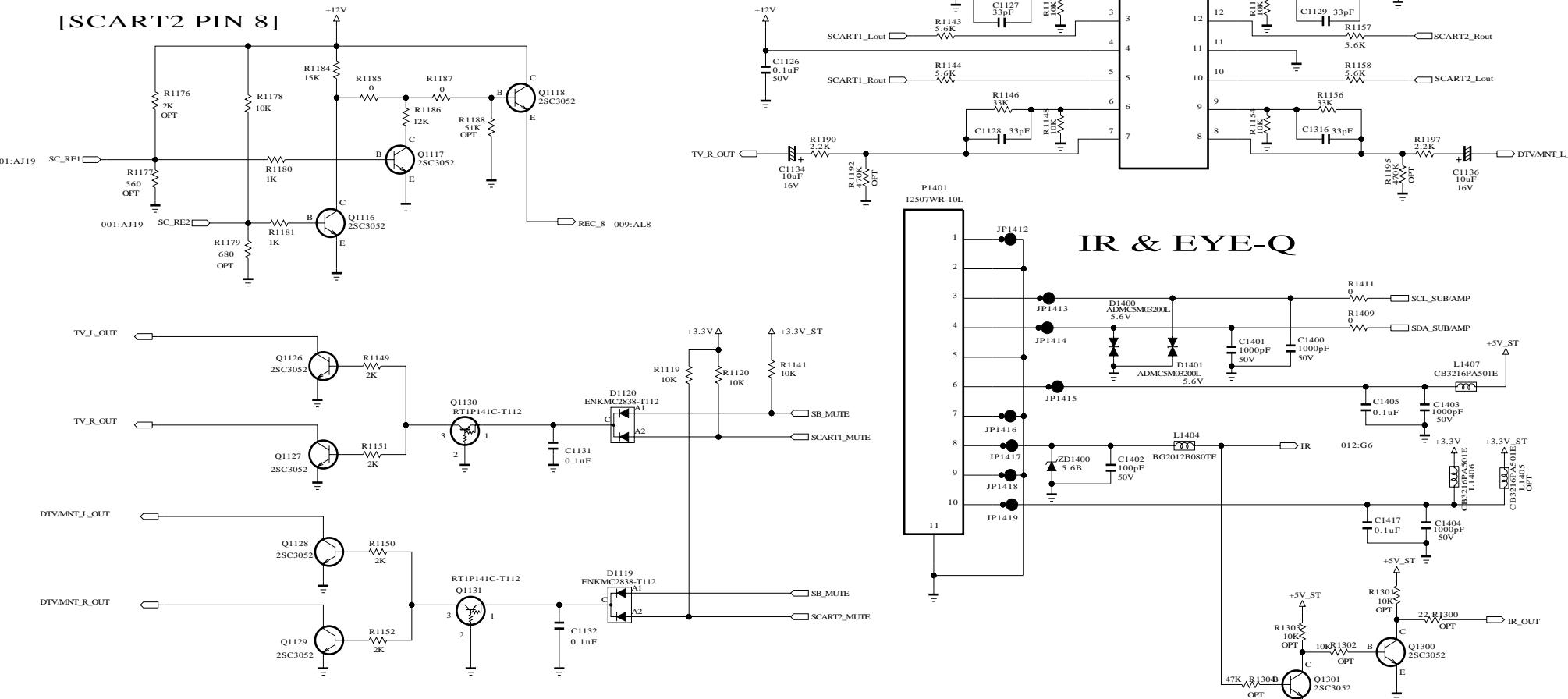
R1/R2 : 12K / 9.1K => Vout=1.85

R1/R2 : 18K / 13K => Vout=1.90

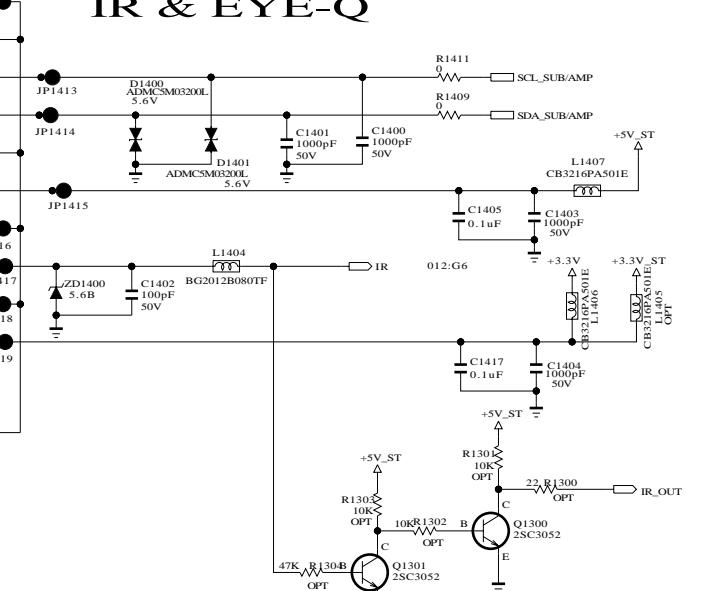
MODEL	EAX60890801	DATE	2009.04.16
BLOCK	POWER	SHEET	8 / 12



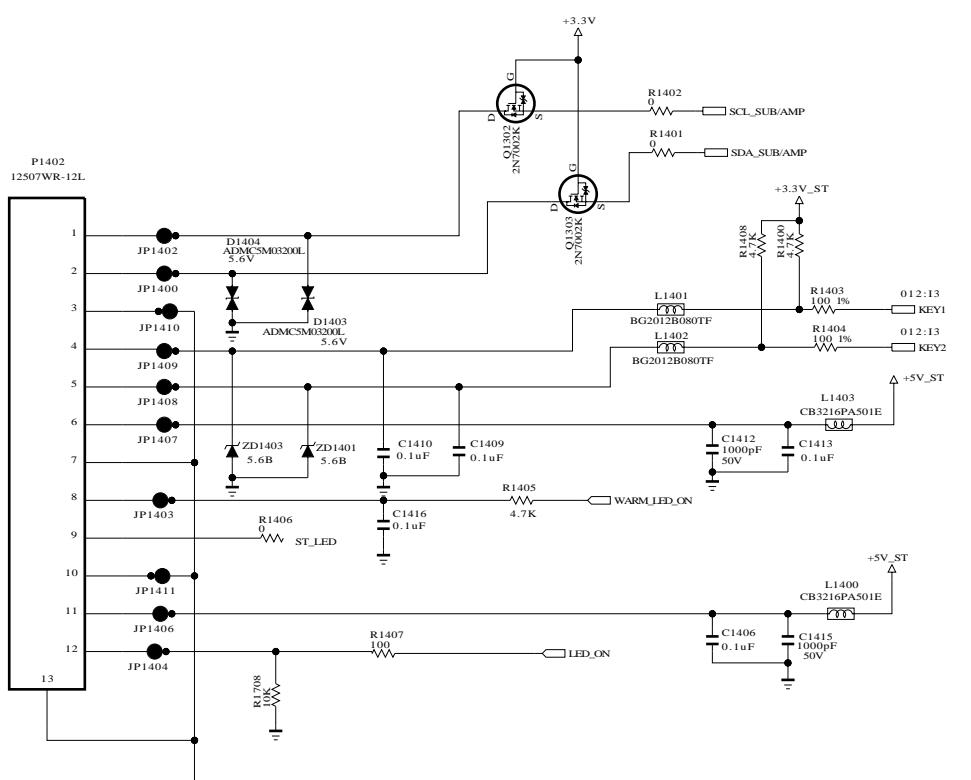
### [SCART2 PIN 8]



### IR & EYE-Q



### CONTROL KEY & BREATHING LED



KEY1 : POWER / INPUT / MENU / ENTER  
KEY2 : VOL- / VOL+ / CH- / CH+

close to wafer

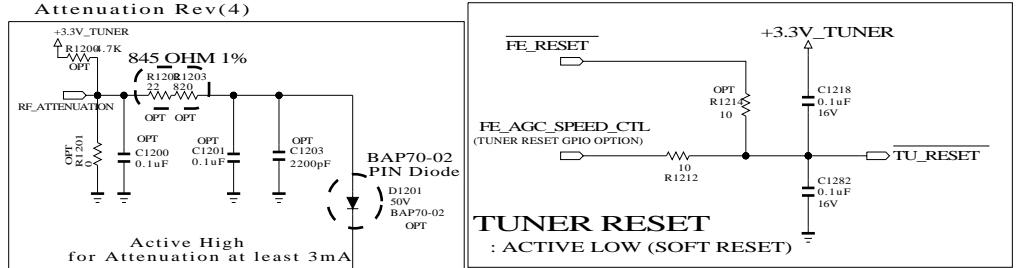
THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

**SECRET**  
LG Electronics

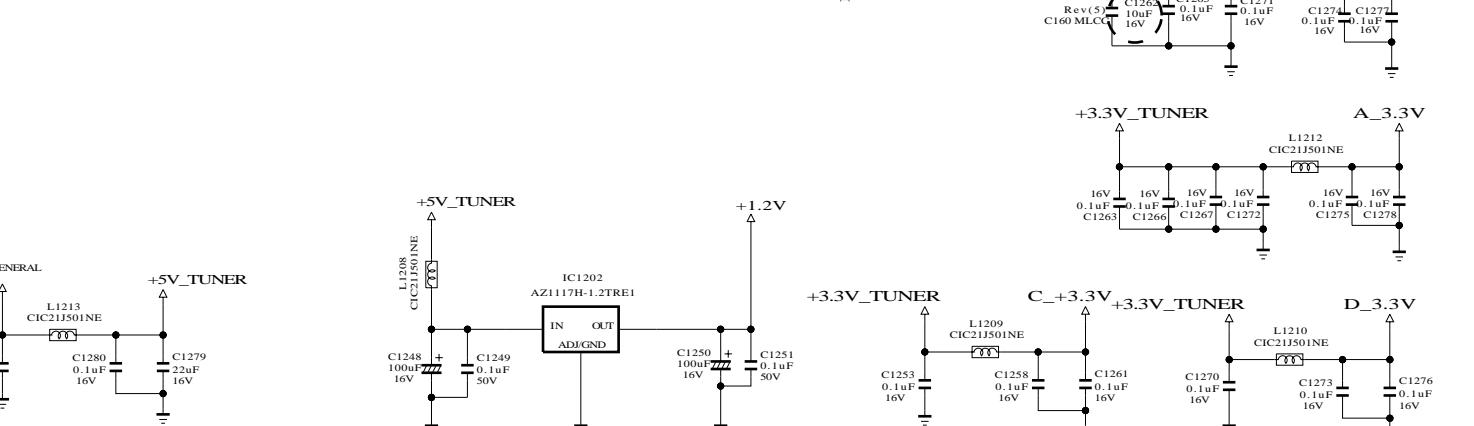
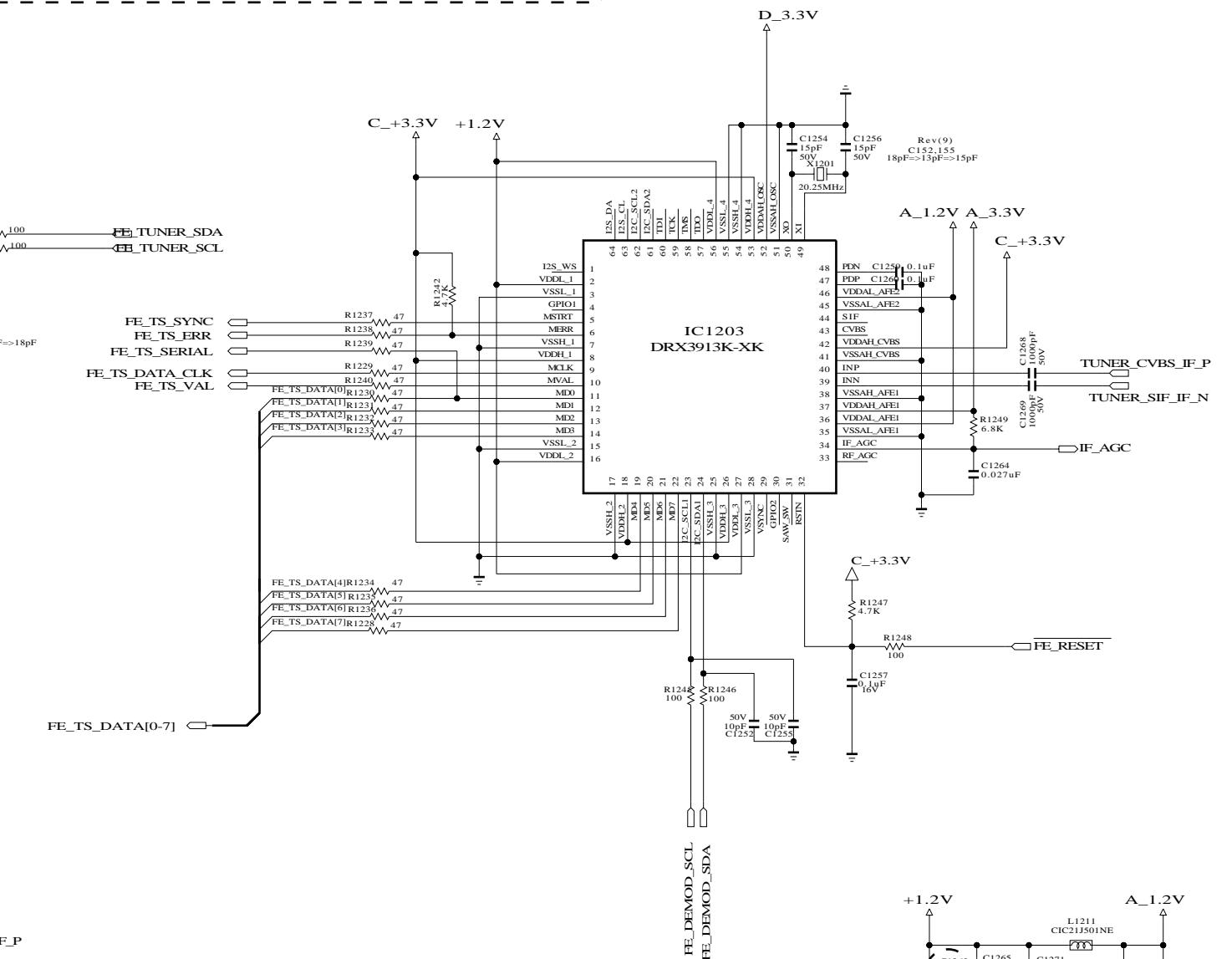
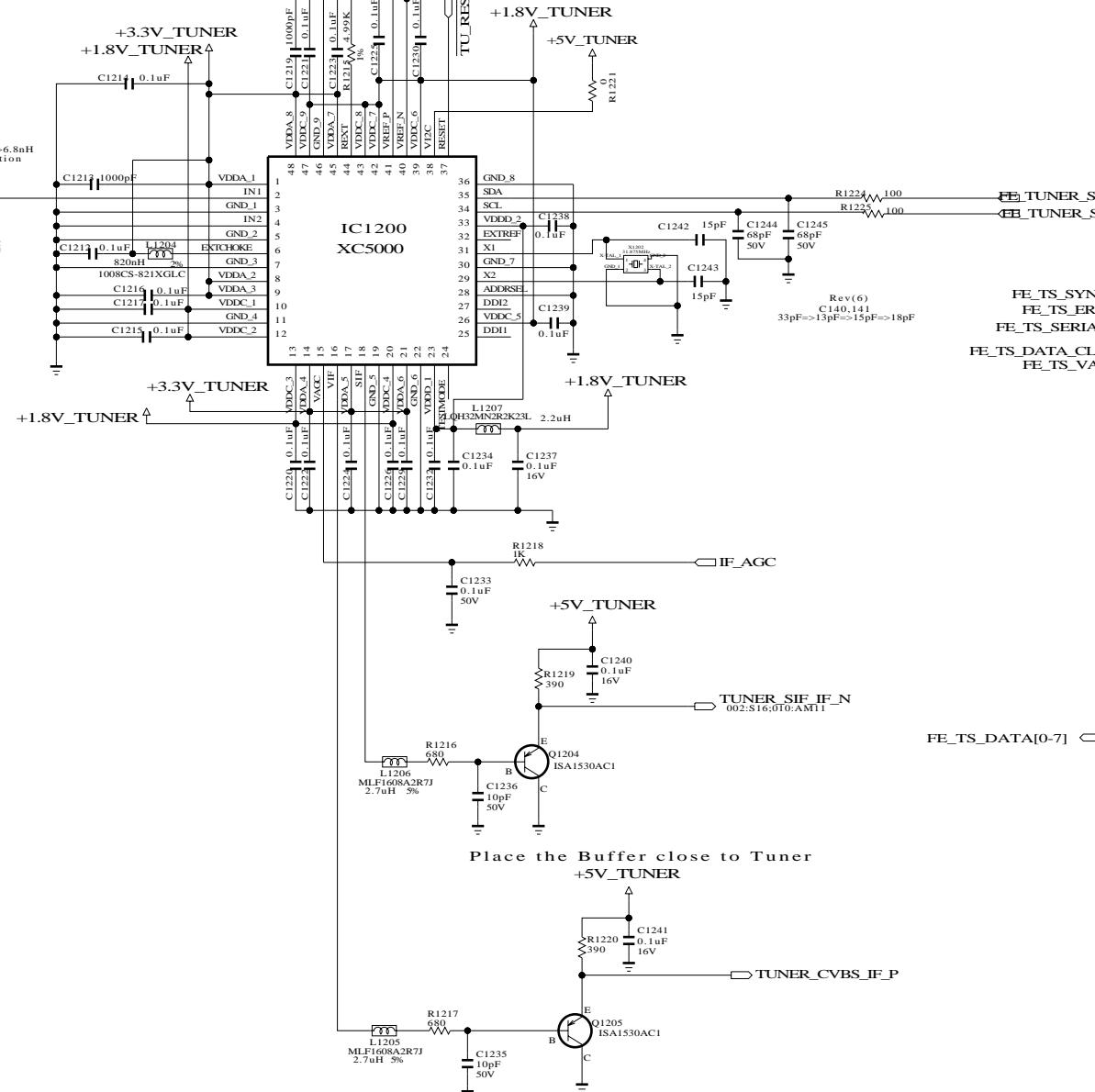
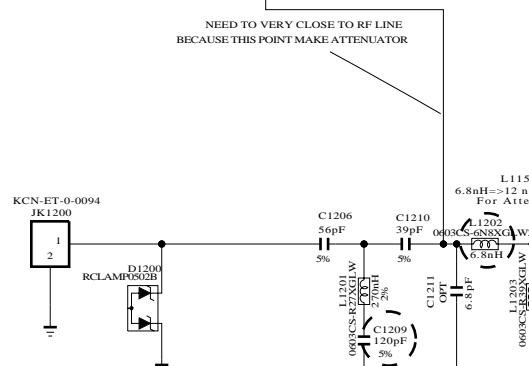
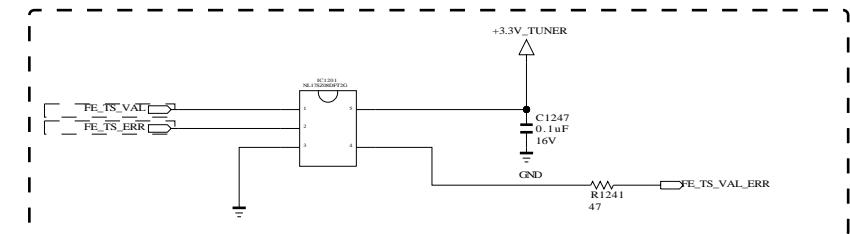
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MODEL	EAX60890801	DATE	2009.04.16
BLOCK	SCART	SHEET	11 / 12

Attenuation Rev(4)



DVB-CI DETECT

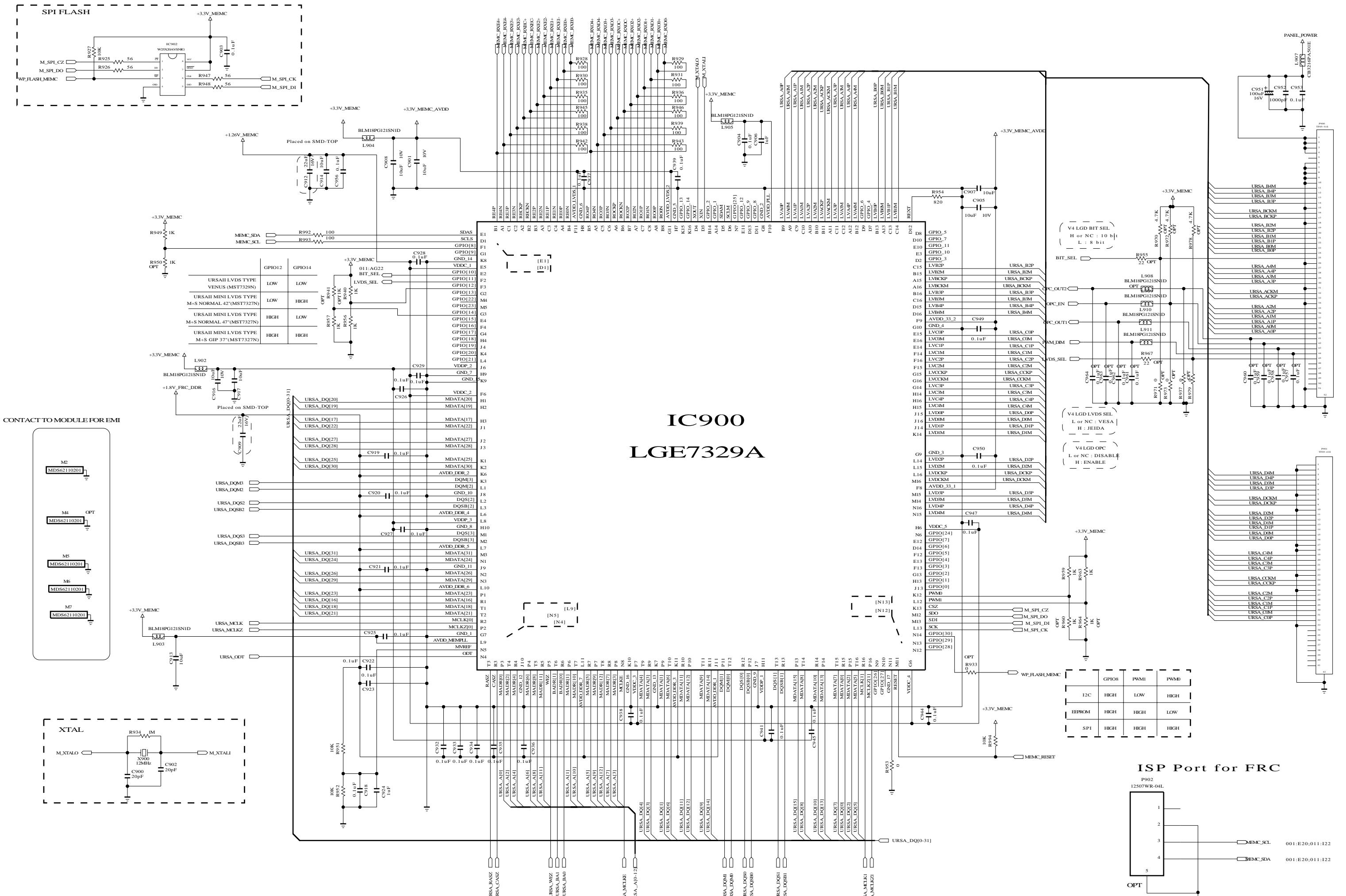


MODEL	EAX60890801	DATE	2009.04.16
BLOCK	TUNER	SHEET	12 / 12

THE SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION. FILRE AND ELECTRICAL SHOCK HAZARDS, WHEN SERVICING IF IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE SYMBOL MARK OF THE SCHEMATIC.

SECRET  
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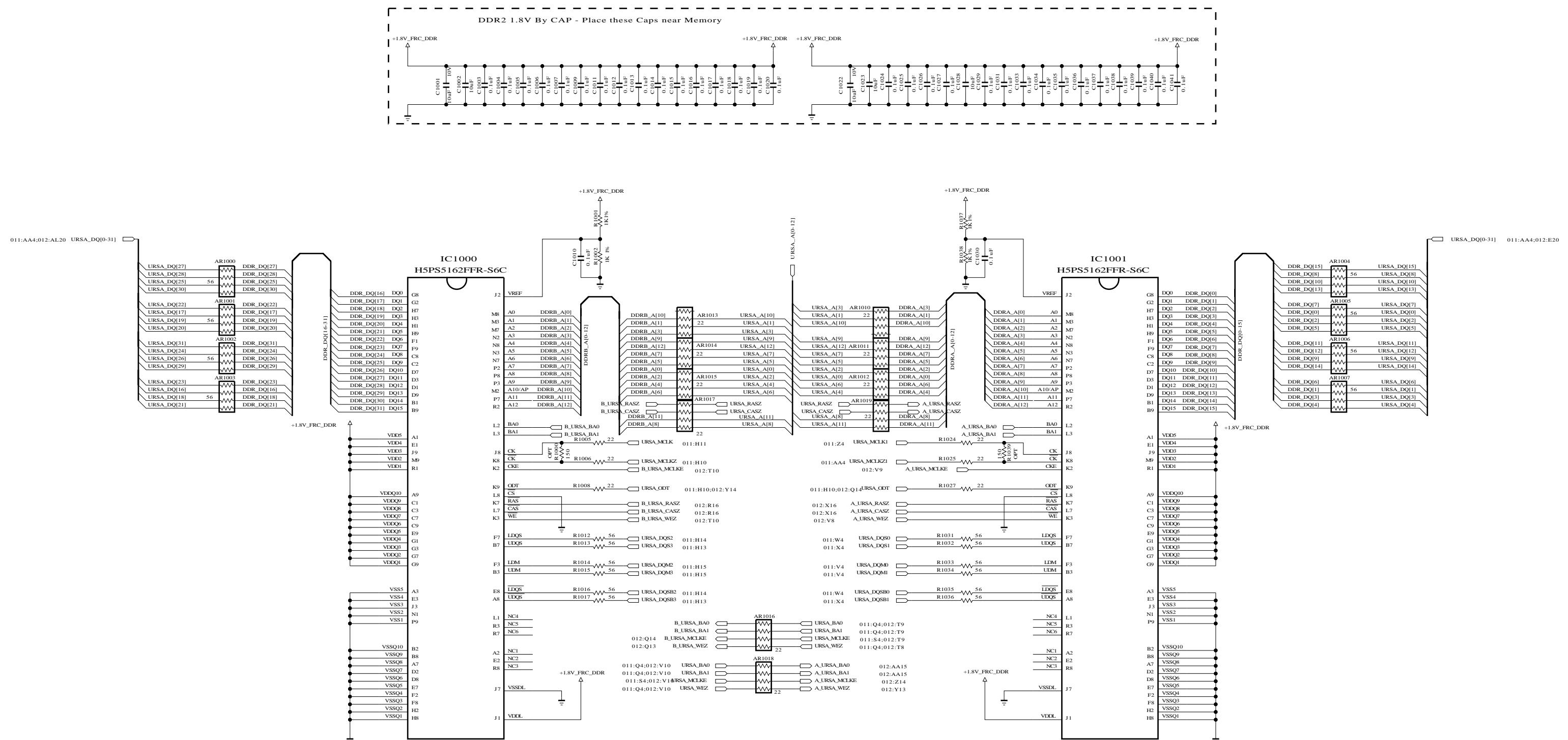


THE  SYMBOL MARK OF THIS SCHEMATIC DIAGRAM INCORPORATES SPECIAL FEATURES IMPORTANT FOR PROTECTION FROM X-RADIATION, FIRE AND ELECTRICAL SHOCK HAZARDS. WHEN SERVICING IT IS ESSENTIAL THAT ONLY MANUFACTURES SPECIFIED PARTS BE USED FOR THE CRITICAL COMPONENTS IN THE  SYMBOL MARK OF THE SCHEMATIC.

SECRET



MODEL	EAX60890801	DATE	2009.04.16
BLOCK	FRC	SHEET	9 / 12





**LG Electronics Inc.**